

# DATA SHEET



## **PCD5002A** Enhanced Pager Decoder for APOC1/POCSAG

Product specification  
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# Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

## CONTENTS

|      |                                          |      |                                                                                |
|------|------------------------------------------|------|--------------------------------------------------------------------------------|
| 1    | FEATURES                                 | 8.41 | Warbled alert                                                                  |
| 2    | APPLICATIONS                             | 8.42 | Direct alert control                                                           |
| 3    | GENERAL DESCRIPTION                      | 8.43 | Alert priority                                                                 |
| 4    | ORDERING INFORMATION                     | 8.44 | Cancelling alerts                                                              |
| 5    | LICENSE                                  | 8.45 | Automatic POCSAG alerts                                                        |
| 6    | BLOCK DIAGRAM                            | 8.46 | SRAM access                                                                    |
| 7    | PINNING                                  | 8.47 | RAM write address pointer (06H; read)                                          |
| 8    | FUNCTIONAL DESCRIPTION                   | 8.48 | RAM read address pointer (08H; read/write)                                     |
| 8.1  | Introduction                             | 8.49 | RAM data output register (09H; read)                                           |
| 8.2  | The POCSAG paging code                   | 8.50 | EEPROM access                                                                  |
| 8.3  | The APOC1 paging code                    | 8.51 | EEPROM address pointer (07H; read/write)                                       |
| 8.4  | Error correction                         | 8.52 | EEPROM data I/O register (0AH; read/write)                                     |
| 8.5  | Operating states                         | 8.53 | EEPROM access limitations                                                      |
| 8.6  | ON status                                | 8.54 | EEPROM read operation                                                          |
| 8.7  | OFF status                               | 8.55 | EEPROM write operation                                                         |
| 8.8  | Reset                                    | 8.56 | Invalid write address                                                          |
| 8.9  | Bit rates                                | 8.57 | Incomplete programming sequence                                                |
| 8.10 | Oscillator                               | 8.58 | Unused EEPROM locations                                                        |
| 8.11 | Input data processing                    | 8.59 | Special programmed function allocation                                         |
| 8.12 | Battery saving                           | 8.60 | Synthesizer programming data                                                   |
| 8.13 | POCSAG synchronization strategy          | 8.61 | Identifier storage allocation                                                  |
| 8.14 | APOC1 synchronization strategy           | 8.62 | Voltage doubler                                                                |
| 8.15 | Call termination                         | 8.63 | Level-shifted interface                                                        |
| 8.16 | Enhanced call termination                | 8.64 | Signal test mode                                                               |
| 8.17 | Call data output format                  | 9    | OPERATING INSTRUCTIONS                                                         |
| 8.18 | Error type indication                    | 9.1  | Reset conditions                                                               |
| 8.19 | Data transfer                            | 9.2  | Power-on reset circuit                                                         |
| 8.20 | Continuous data decoding                 | 9.3  | Reset timing                                                                   |
| 8.21 | Receiver and oscillator control          | 9.4  | Initial programming                                                            |
| 8.22 | Demodulator quick charge                 | 10   | LIMITING VALUES                                                                |
| 8.23 | External receiver control and monitoring | 11   | DC CHARACTERISTICS                                                             |
| 8.24 | Battery condition input                  | 12   | DC CHARACTERISTICS (WITH VOLTAGE CONVERTER)                                    |
| 8.25 | Synthesizer control                      | 13   | OSCILLATOR CHARACTERISTICS                                                     |
| 8.26 | Serial microcontroller interface         | 14   | AC CHARACTERISTICS                                                             |
| 8.27 | Decoder I <sup>2</sup> C-bus access      | 15   | APPLICATION INFORMATION                                                        |
| 8.28 | External interrupt                       | 16   | PACKAGE OUTLINE                                                                |
| 8.29 | Interrupt masking                        | 17   | SOLDERING                                                                      |
| 8.30 | Status/control register                  | 17.1 | Introduction to soldering surface mount packages                               |
| 8.31 | Pending interrupts                       | 17.2 | Reflow soldering                                                               |
| 8.32 | Out-of-range indication                  | 17.3 | Wave soldering                                                                 |
| 8.33 | Real-time clock                          | 17.4 | Manual soldering                                                               |
| 8.34 | Periodic interrupt                       | 17.5 | Suitability of surface mount IC packages for wave and reflow soldering methods |
| 8.35 | Received call delay                      | 18   | DEFINITIONS                                                                    |
| 8.36 | Alert generation                         | 19   | LIFE SUPPORT APPLICATIONS                                                      |
| 8.37 | Alert cadence register (03H; write)      | 20   | PURCHASE OF PHILIPS I <sup>2</sup> C COMPONENTS                                |
| 8.38 | Acoustic alert                           |      |                                                                                |
| 8.39 | Vibrator alert                           |      |                                                                                |
| 8.40 | LED alert                                |      |                                                                                |

# Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

## 1 FEATURES

- Wide operating supply voltage range: 1.5 to 6.0 V
- EEPROM programming requires only 2.0 V supply
- Low operating current: 50  $\mu$ A typ. (ON), 25  $\mu$ A typ. (OFF)
- Temperature range  $-25$  to  $+70$   $^{\circ}$ C
- "CCIR radio paging Code No. 1" (POCSAG) compatible
- Supports Advanced Pager Operator's Code Phase 1 (APOC1) for extended battery economy
- 512, 1200 and 2400 bits/s data rates using 76.8 kHz crystal
- Built-in data filter (16 times oversampling) and bit clock recovery
- Advanced ACCESS<sup>®</sup> synchronization algorithm
- 2-bit random and (optional) 4-bit burst error correction
- Up to 6 user addresses Receiver Identity Codes (RICs), each with 4 functions/alert cadences
- Optional automatic call termination when bit error rate is high
- Up to 6 user address frames, independently programmable
- Standard POCSAG sync word, plus up to 4 user programmable sync words
- Continuous data decoding upon reception of user programmable sync word (optional)
- Received data inversion (optional)
- Call alert via beeper, vibrator or LED
- 2-level acoustic alert using single external transistor
- Alert control: automatic (POCSAG type), via cadence register or alert input pin
- Separate power control of receiver and RF oscillator for battery economy
- Dedicated pin for easy control of superheterodyne receiver
- Synthesizer set-up and control interface (3-line serial)
- On-chip EEPROM for storage of user addresses (RICs), pager configuration and synthesizer data
- On-chip SRAM buffer for message data



- Slave I<sup>2</sup>C-bus interface to microcontroller for transfer of message data, status/control and EEPROM programming (data transfer at up to 100 kbits/s)
- Wake-up interrupt for microcontroller, programmable polarity
- Direct and I<sup>2</sup>C-bus control of operating status (ON/OFF)
- Battery-low indication (external detector)
- Out-of-range condition indication
- Real-time clock reference output
- On-chip voltage doubler
- Interfaces directly to UAA2080 and UAA2082 paging receivers.

## 2 APPLICATIONS

- Advanced display pagers (POCSAG and APOC1)
- Basic alert-only pagers
- Information services
- Personal organizers
- Telepoint
- Telemetry/data transmission.

## 3 GENERAL DESCRIPTION

The PCD5002A is a very low power pager decoder and controller, capable of handling both standard POCSAG and the advanced APOC1 code. Continuous data decoding upon reception of a dedicated sync word is available for news pager applications.

Data rates supported are 512, 1200 and 2400 bits/s using a single 76.8 kHz crystal. On-chip EEPROM is programmable using a minimum supply voltage of 2.0 V, allowing 'over-the-air' programming. I<sup>2</sup>C-bus compatible.

## 4 ORDERING INFORMATION

| TYPE NUMBER | PACKAGE |                                                                      |          |
|-------------|---------|----------------------------------------------------------------------|----------|
|             | NAME    | DESCRIPTION                                                          | VERSION  |
| PCD5002AH   | LQFP32  | plastic low profile quad flat package; 32 leads; body 7 × 7 × 1.4 mm | SOT358-1 |

Enhanced Pager Decoder for  
APOC1/POCSAG

PCD5002A

5 LICENSE

Supply of this IC does neither convey nor express an implied license under any patent right to use this in any APOC application.

6 BLOCK DIAGRAM

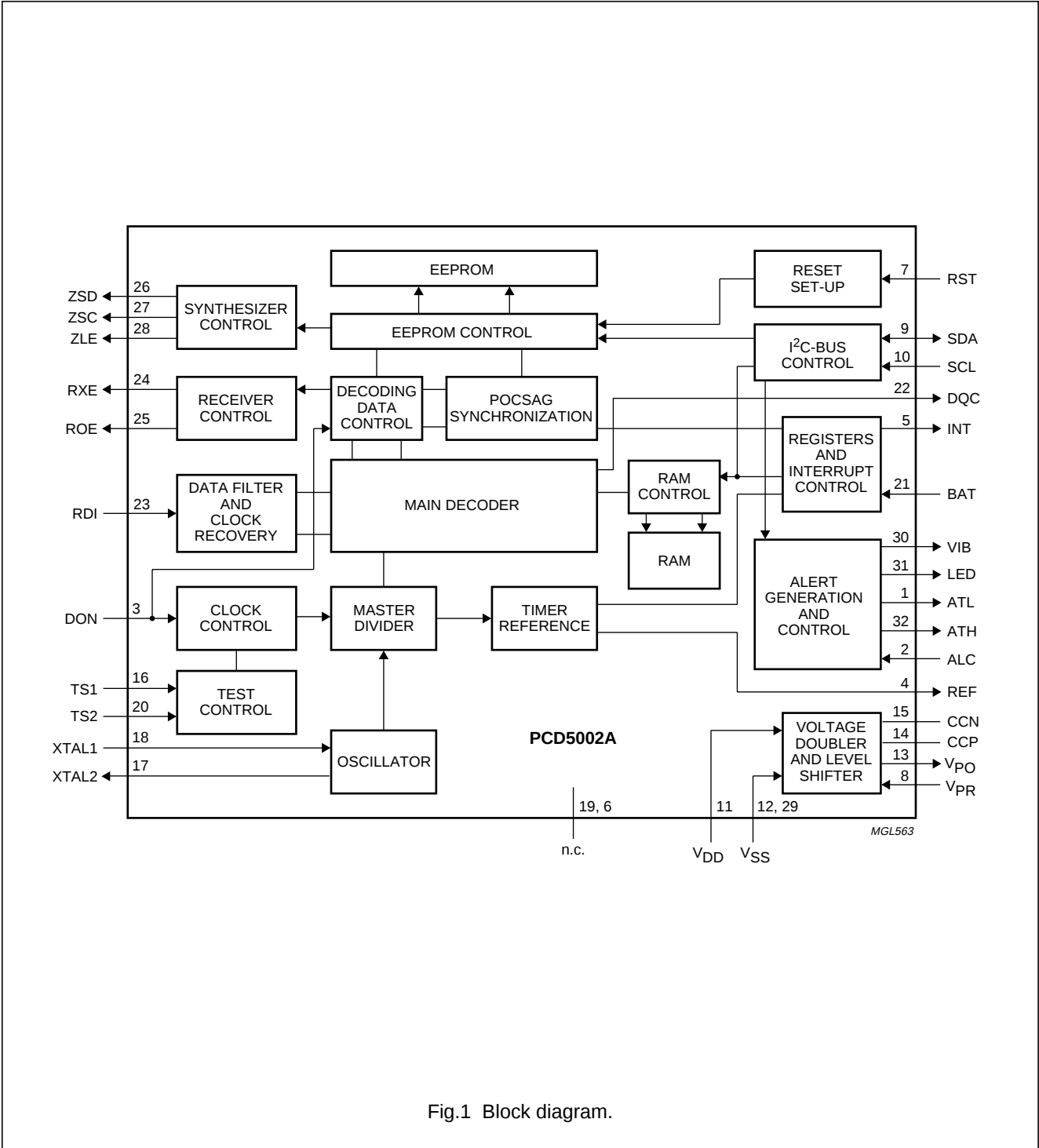


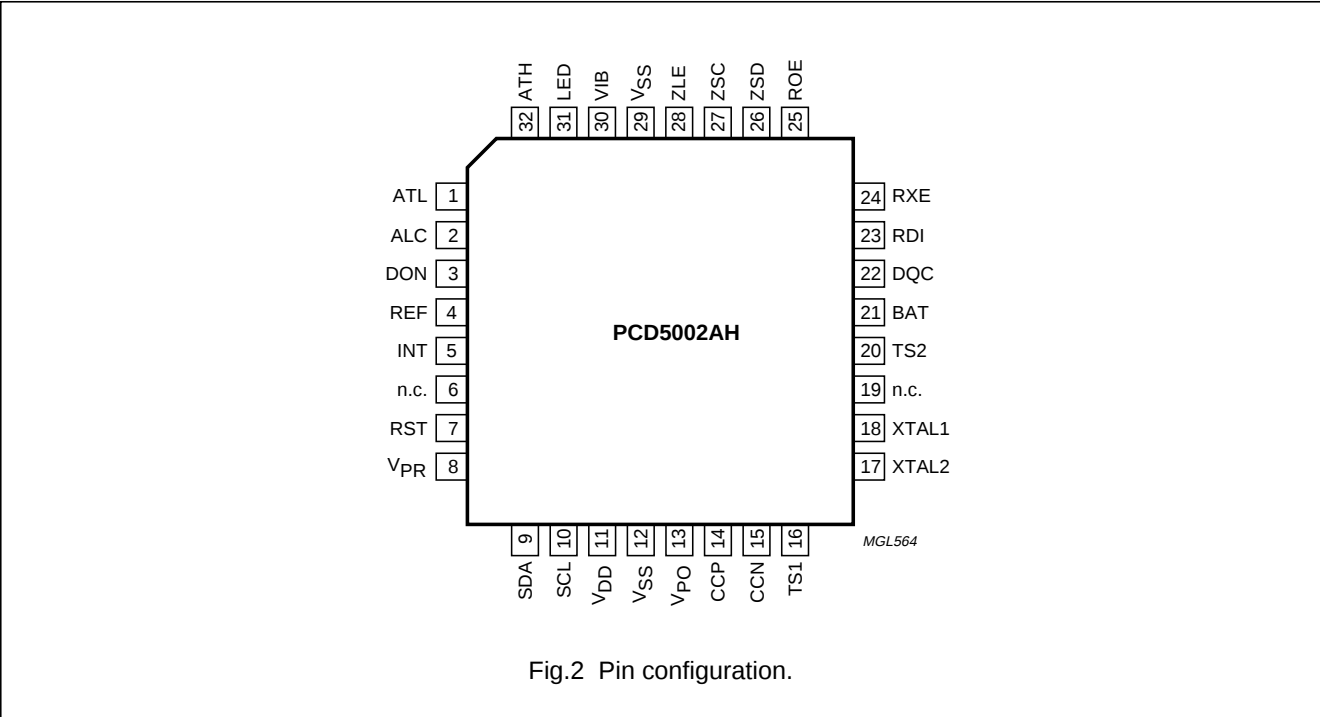
Fig.1 Block diagram.

Enhanced Pager Decoder for  
APOC1/POCSAG

PCD5002A

7 PINNING

| SYMBOL | PIN | DESCRIPTION                                              | SYMBOL | PIN | DESCRIPTION                                       |
|--------|-----|----------------------------------------------------------|--------|-----|---------------------------------------------------|
| ATL    | 1   | alert LOW level output                                   | TS1    | 16  | test input 1 (normally LOW by internal pull-down) |
| ALC    | 2   | alert control input (normally LOW by internal pull-down) | XTAL2  | 17  | decoder crystal oscillator output                 |
| DON    | 3   | direct ON/OFF input (normally LOW by internal pull-down) | XTAL1  | 18  | decoder crystal oscillator input                  |
| REF    | 4   | real-time clock frequency reference output               | n.c.   | 19  | not connected                                     |
| INT    | 5   | interrupt output                                         | TS2    | 20  | test input 2 (normally LOW by internal pull-down) |
| n.c.   | 6   | not connected                                            | BAT    | 21  | battery sense input                               |
| RST    | 7   | reset input (normally LOW by internal pull-down)         | DQC    | 22  | demodulator quick charge output                   |
| VPR    | 8   | external positive voltage reference input                | RDI    | 23  | received data input (POCSAG or APOC1)             |
| SDA    | 9   | I <sup>2</sup> C-bus serial data input/output            | RXE    | 24  | receiver circuit enable output                    |
| SCL    | 10  | I <sup>2</sup> C-bus serial clock input                  | ROE    | 25  | receiver oscillator enable output                 |
| VDD    | 11  | main positive supply voltage                             | ZSD    | 26  | synthesizer serial data output                    |
| VSS    | 12  | main negative supply voltage                             | ZSC    | 27  | synthesizer serial clock output                   |
| VPO    | 13  | voltage converter positive output                        | ZLE    | 28  | synthesizer latch enable output                   |
| CCP    | 14  | voltage converter shunt capacitor (positive side)        | VSS    | 29  | main negative supply voltage                      |
| CCN    | 15  | voltage converter shunt capacitor (negative side)        | VIB    | 30  | vibrator motor drive output                       |
|        |     |                                                          | LED    | 31  | LED drive output                                  |
|        |     |                                                          | ATH    | 32  | alert HIGH level output                           |



## Enhanced Pager Decoder for APOC1/POCSAG

## PCD5002A

### 8 FUNCTIONAL DESCRIPTION

#### 8.1 Introduction

The PCD5002A is a very low power decoder and pager controller specifically designed for use in new generation radio pagers. The architecture of the PCD5002A allows for flexible application in a wide variety of radio pager designs.

The PCD5002A is fully compatible with “*CCIR Radio paging Code No. 1*” (also known as the POCSAG code) operating at data rates of 512, 1200 and 2400 bits/s using a single oscillator crystal of 76.8 kHz.

The PCD5002A also supports the new Advanced Pager Operator's Code Phase 1 (APOC1). This compatible extension to the POCSAG code improves battery economy by introducing ‘cycles’ and batch numbering. A cycle consists of 5 or 15 standard POCSAG batches. Each pager will be allocated a batch number in addition to its POCSAG address and it will only search for its address during this batch.

In addition to the standard POCSAG sync word (used also in APOC1) the PCD5002A is also capable of recognizing up to 4 User Programmable Sync Words (UPSWs). This permits the reception of both private services and POCSAG or APOC1 transmissions via the same radio channel. As an option reception of a UPSW may activate Continuous Data Decoding (CDD).

Used together with the Philips UAA2080 or UAA2082 paging receiver, the PCD5002A offers a highly sophisticated, miniature solution for the radio paging market. Control of an RF synthesizer circuit is also provided to ease alignment and channel selection.

On-chip EEPROM provides storage for user addresses (Receiver Identity Codes or RICs) and Special Programmed Functions (SPFs) and UPSWs, which eliminates the need for external storage devices and interconnection. For other non-volatile storage 20 bytes of general purpose EEPROM are available. The low EEPROM programming voltage makes the PCD5002A well suited for ‘over-the-air’ programming/reprogramming.

On request from an external controlling device or automatically (by SPF programming), the PCD5002A will provide standard POCSAG alert cadences by driving a standard acoustic ‘beeper’. Non-standard alert cadences may be generated via a cadence register or a dedicated control input.

The PCD5002A can also produce a HIGH level acoustic alert as well as drive an LED indicator and a vibrator motor via external bipolar transistors.

The PCD5002A contains a low-power, high-efficiency voltage converter (doubler) designed to provide a higher voltage supply to LCD drivers or microcontrollers. In addition, an independent level shifted interface is provided allowing communication to a microcontroller operating at a higher voltage than the PCD5002A.

Interface to such an external device is provided by an I<sup>2</sup>C-bus which allows received call identity and message data, data for the programming of the internal EEPROM, alert control and pager status information to be transferred between the devices. Pager status includes features provided by the PCD5002A such as battery-low and out-of-range indications. A dedicated interrupt line minimizes the required microcontroller activity.

A selectable low frequency timing reference is provided for use in real-time clock functions.

Data synchronization is achieved by the Philips patented ACCESS<sup>®</sup> algorithm ensuring that maximum advantage is made of the POCSAG code structure particularly in fading radio signal conditions. The algorithm allows for data synchronization without preamble detection whilst minimizing battery power consumption. The APOC1 code uses an extended version of the ACCESS<sup>®</sup> synchronization algorithm.

Random (and optional) burst error correction techniques are applied to the received data to optimize the call success rate without increasing the falsing rate beyond specified POCSAG levels.

#### 8.2 The POCSAG paging code

A transmission using the “*CCIR Radio paging Code No. 1*” (POCSAG code) is constructed in accordance with the following rules (see Fig.3).

The transmission is started by sending a **preamble**, consisting of at least 576 continuously alternating bits (10101010...). The preamble is followed by an arbitrary number of batch blocks. Only complete batches are transmitted.

Each **batch** comprises 17 code-words of 32 bits each. The first code-word is a synchronization code-word with a fixed pattern. The **sync** word is followed by 8 frames (0 to 7) of 2 code-words each, containing message information. A code-word in a frame can either be an address, message or idle code-word.

**Idle** code-words also have a fixed pattern and are used to fill empty frames or to separate messages.

Enhanced Pager Decoder for  
APOC1/POCSAG

PCD5002A

Address code-words are identified by an MSB at logic 0 and are coded as shown in Fig.3. A user address or RIC consists of 21 bits. Only the upper 18 bits are encoded in the address code-word (bits 2 to 19). The lower 3 bits designate the frame number (0 to 7) in which the address is transmitted.

Four different call types ('numeric', 'alphanumeric' and two 'alert only' types) can be distinguished. The call type is determined by two function bits in the address code-word (bits 20 and 21), as shown in Table 1.

Alert-only calls consist only of a single address code-word. Numeric and alphanumeric calls have message code-words following the address. A message causes the frame structure to be temporarily suspended. Message code-words are sent until the message is completed, with only the sync words being transmitted in their expected positions.

**Message** code-words are identified by an MSB at logic 1 and are coded as shown in Fig.3. The message information is stored in a 20-bit field (bits 2 to 21).

The standard data format is determined by the call type: 4 bits per digit for numeric messages and 7 bits per (ASCII) character for alphanumeric messages.

Each code-word is protected against transmission errors by 10 CRC check bits (bits 22 to 31) and an even-parity bit (bit 32).

This permits correction of a maximum of 2 random errors or up to 3 errors in a burst of 4 bits (a 4-bit burst error) per code-word.

### 8.3 The APOC1 paging code

The APOC1 paging code is fully POCSAG compatible and involves the introduction of batch grouping and a Batch Zero Identifier (BZI). This reserved address code-word indicates the start of a 'cycle' of 5 or 15 batches long and is transmitted immediately after a sync word.

Cycle transmission must be coherent i.e. a transmission starting an integer number of cycle periods after the start of the previous one.

Broadcast message data may be included in a transmission. This information may occupy any number of message code-words and immediately follows the batch zero identifier of the first cycle after preamble.

The presence of data is indicated by the function bits in the batch zero identifier: 1,1 indicates 'no broadcast data'. Any other combination indicates a broadcast message.

The PCD5002A can be configured for POCSAG or APOC1 operation via SPF programming. The batch zero identifier is programmable and can be stored in any identifier location in EEPROM.

The POCSAG standard only allows combinations of data formats and function code bits as given in Table 1. However, other (non-standard) combinations will be decoded normally by the PCD5002A.

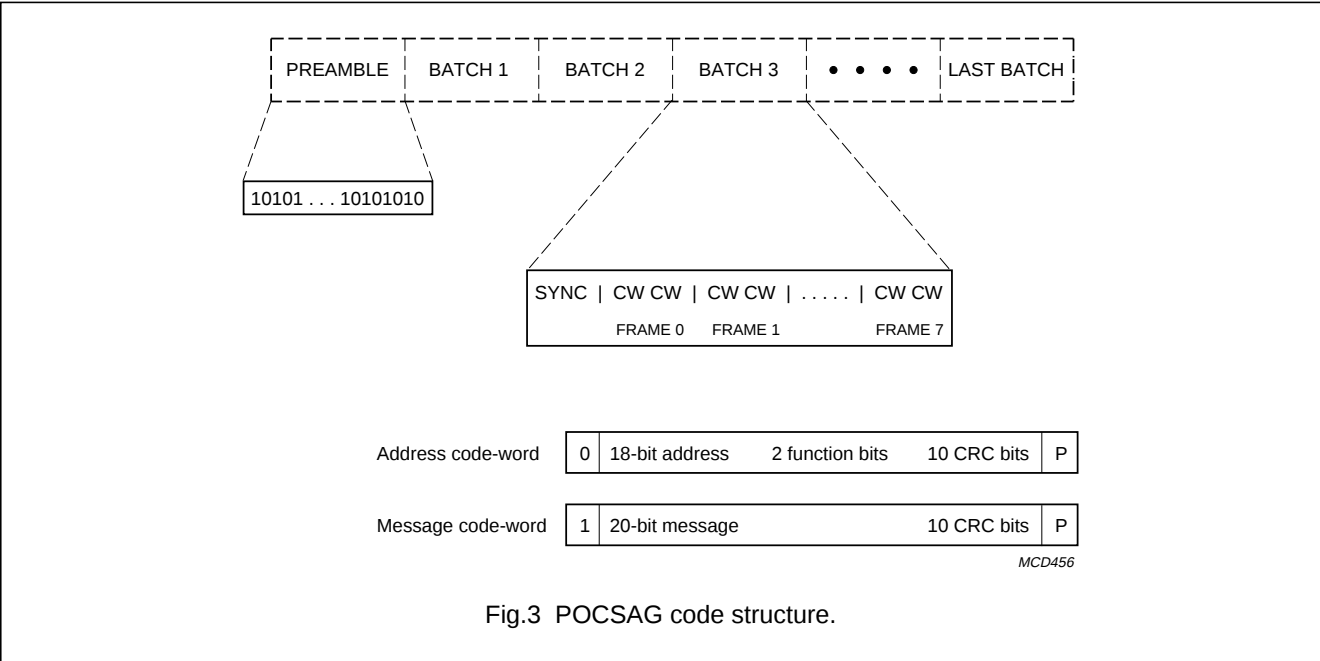


Fig.3 POCSAG code structure.

# Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

**Table 1** POCSAG recommended call types and function bits

| BIT 20 (MSB) | BIT 21 (LSB) | CALL TYPE    | DATA FORMAT                |
|--------------|--------------|--------------|----------------------------|
| 0            | 0            | numeric      | 4-bits per digit           |
| 0            | 1            | alert only 1 | –                          |
| 1            | 0            | alert only 2 | –                          |
| 1            | 1            | alphanumeric | 7-bits per ASCII character |

## 8.4 Error correction

In the PCD5002A error correction methods have been implemented as shown in Table 2.

Random error correction is default for both address and message code-words. In addition, burst error correction can be enabled by SPF programming. Up to 3 erroneous bits in a 4-bit burst can be corrected.

The error type detected for each code-word is identified in the message data output to the microcontroller, allowing rejection of calls with too many errors.

**Table 2** Error correction

| ITEM                      | CORRECTION                                          |
|---------------------------|-----------------------------------------------------|
| Preamble                  | 4 random errors in 31 bits                          |
| Synchronization code-word | 2 random errors in 32 bits                          |
| Address code-word         | 2 random errors; plus 4-bit burst errors (optional) |
| Message code-word         | 2 random errors; plus 4-bit burst errors (optional) |

## 8.5 Operating states

The PCD5002A has 2 operating states:

- ON status
- OFF status.

The operating state is determined by a direct control input (DON) and bit D4 in the control register (see Table 3).

**Table 3** Truth table for decoder operating status

| DON INPUT | CONTROL BIT D4 | OPERATING STATUS |
|-----------|----------------|------------------|
| 0         | 0              | OFF              |
| 0         | 1              | ON               |
| 1         | 0              | ON               |
| 1         | 1              | ON               |

## 8.6 ON status

In the ON status the decoder pulses the receiver and oscillator enable outputs (RXE and ROE respectively) according to the code structure and the synchronization algorithm. Data received serially at the data input (RDI) is processed for call reception.

The data protocol can be POCSAG or APOC1. Continuous data decoding upon reception of a special sync word is also supported. The data protocol is selected by SPF programming.

Reception of a valid paging call is signalled to the microcontroller by an interrupt signal. The received address and message data can then be read via the I<sup>2</sup>C-bus interface.

## 8.7 OFF status

In the OFF status the decoder will neither activate the receiver or oscillator enable outputs, nor process any data at the data input. The crystal oscillator remains active to permit communication with the microcontroller.

In both operating states an accurate timing reference is available via the REF output. Using SPF programming the signal periodicity may be selected as; 32.768 kHz, 50 Hz, 2 Hz or  $\frac{1}{60}$  Hz.

## 8.8 Reset

The decoder can be reset by applying a positive pulse on input pin RST. For successful reset at power-on, a HIGH level must be present on the RST pin while the device is powering-up.

This can be applied by the microcontroller, or via a suitable RC power-on reset circuit connected to the RST input. Reset circuit details and conditions during and after a reset are described in Chapter 9.

## Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

### 8.9 Bit rates

The PCD5002A can be configured for data rates of 512, 1200 or 2400 bits/s by SPF programming. These data rates are derived from a single 76.8 kHz oscillator frequency.

### 8.10 Oscillator

The oscillator circuit is designed to operate at 76.8 kHz. Typically, a tuning fork crystal will be used as a frequency source. Alternatively, an external clock signal can be applied to pin XTAL1 (amplitude =  $V_{DD}$  to  $V_{SS}$ ), but a slightly higher oscillator current is consumed. A 2.2 M $\Omega$  feedback resistor connected between XTAL1 and XTAL2 is required for proper operation.

To allow easy oscillator adjustment (e.g. by a variable capacitor) a 32.768 kHz reference frequency can be selected at output REF by SPF programming.

### 8.11 Input data processing

Data input is binary and fully asynchronous. Input bit rates of 512, 1200 and 2400 bits/s are supported. As a programmable option, the polarity of the received data can be inverted before further processing.

The input data is noise filtered by a digital filter. Data is sampled at 16 times the data rate and averaged by majority decision.

The filtered data is used to synchronize an internal clock generator by monitoring transitions. The recovered clock phase can be adjusted in steps of  $\frac{1}{8}$  or  $\frac{1}{32}$  bit period per received bit.

The larger step size is used when bit synchronization has not been achieved, the smaller when a valid data sequence has been detected (e.g. preamble or sync word).

### 8.12 Battery saving

Current consumption is reduced by switching off internal decoder sections whenever the receiver is not enabled.

To further increase battery efficiency, reception and decoding of an address code-word is stopped as soon as the uncorrected address field differs by more than 3 bits from the enabled RICs. If the next code-word must be received again, the receiver is re-enabled thus observing the programmed establishment times  $t_{RXE}$  and  $t_{ROE}$ .

The current consumption of the complete pager can be minimized by separately activating the RF oscillator circuit (using output ROE) before activating the rest of the receiver. This is possible using the UAA2082 receiver which has external biasing for the oscillator circuit.

### 8.13 POCSAG synchronization strategy

In the ON status the PCD5002A synchronizes to the POCSAG data stream by the Philips ACCESS<sup>®</sup> algorithm. A flow diagram is shown in Fig.4. Where 'sync word' is used, this implies both the standard POCSAG sync word and any enabled User Programmable Sync Word (UPSW).

Several modes of operation can be distinguished depending on the synchronization state. Each mode uses a different method to obtain or retain data synchronization. The receiver and oscillator enable outputs (RXE and ROE respectively) are switched accordingly, with the appropriate establishment times ( $t_{RXON}$  and  $t_{ROON}$  respectively).

Before comparing received data with preamble, an enabled sync word or programmed user addresses, the appropriate error correction is applied.

Initially, after switching to the ON status, the decoder is in **switch-on** mode. Here the receiver will be enabled for a period up to 3 batches, testing for preamble and the sync word. Failure to detect preamble or the sync word will cause the device to switch to the 'carrier off' mode.

When preamble is detected it will cause the device to switch to the **preamble receive** mode, in which a sync word is searched for. The receiver will remain enabled while preamble is detected. When neither sync word nor preamble is found within a 1 batch duration the 'carrier off' mode is entered.

Upon detection of a sync word the **data receive** mode is entered. The receiver is activated only during enabled user address frames and sync word periods. When an enabled user address has been detected, the receiver will be kept enabled for message code-word reception until the call termination criteria are met.

During call reception data bytes are stored in an internal SRAM buffer, capable of storing 2 batches of message data.

Messages are transmitted contiguously, only interrupted by sync words at the beginning of each batch.

## Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

When a message extends beyond the end of a batch no testing for sync takes place. Instead, a message data transfer will be initiated by an interrupt to the external controller. Data reception continues normally after a period corresponding to the sync word duration.

If any message code-word is found to be uncorrectable, the 'data fail' mode is entered and no data transfer will be attempted at the next sync word position. Instead, a test for sync word will be carried out.

In the **data fail** mode message reception continues normally for 1 batch duration. When a sync word is detected at the expected position the decoder returns to the 'data receive' mode. If the sync word again fails to appear, then batch synchronization is deemed lost. Call reception is then terminated and the 'fade recovery' mode is entered.

The **fade recovery** mode is intended to scan for sync word and preamble over an extended window (nominal position  $\pm 8$  bits). This is performed for a period of up to

15 batches, allowing recovery of synchronization from long fades in the radio signal. Detection of preamble causes switching to the 'preamble receive' mode, while sync word detection causes switching to the 'data receive' mode. When neither is found within a period of 15 batches, the radio signal is considered lost and the 'carrier off' mode is entered.

The purpose of the **carrier off** mode is to detect a valid radio transmission and synchronize to it quickly and efficiently. Because transmissions may start at random, the decoder enables the receiver for 1 code-word in every 18 code-words looking for preamble or sync word. By using a buffer containing 32 bits (n bits from the current scan, 32 – n from the previous scan) effectively every batch bit position can be tested within a continuous transmission of at least 18 batches. Detection of preamble causes the device to switch to the 'preamble receive' mode, while sync word detection causes the device to switch to the 'data receive' mode.

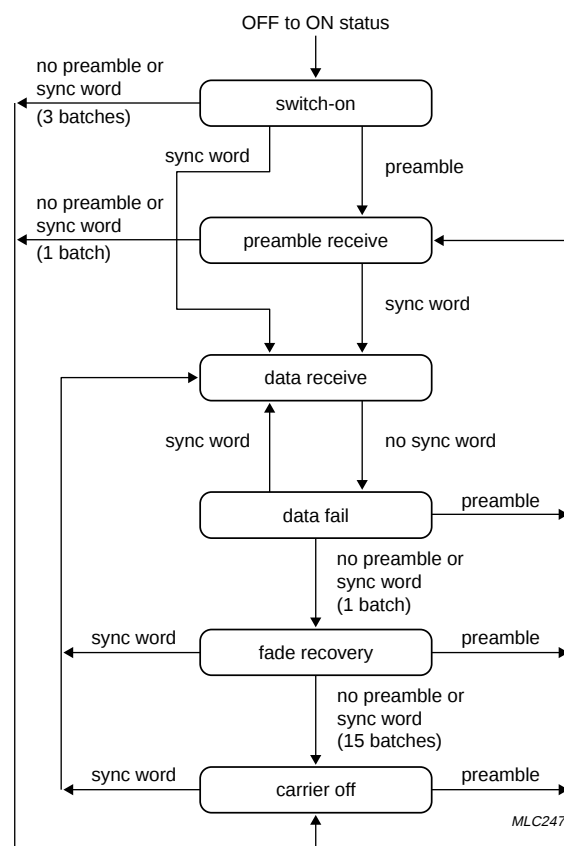


Fig.4 ACCESS® synchronization algorithm for POCSAG.

## Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

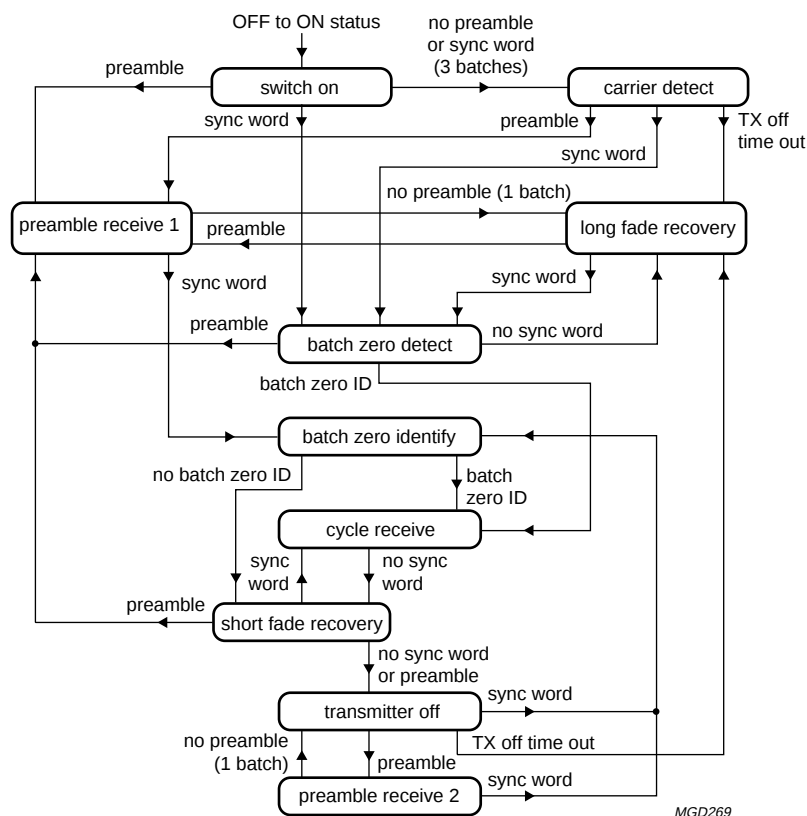


Fig.5 APOC1 synchronization algorithm.

### 8.14 APOC1 synchronization strategy

The synchronization strategy in APOC1 is an extended version of the ACCESS<sup>®</sup> scheme and is illustrated in Fig.5. The PCD5002A counts the number of batches in a transmission, starting from the first batch received after preamble. Counter overflow occurs due to the size of a cycle, as determined by SPF programming.

Initially, after switching to the ON status, the decoder will be in the **switch-on** mode. Here the receiver will be enabled for up to 3 batches, testing for preamble and sync word. Detection of preamble causes the device to switch to the 'preamble receive' mode, while any enabled sync word enters the 'batch zero detect' mode. Failure to detect either will cause the device to switch to the 'carrier detect' mode.

In the **preamble receive 1** mode the PCD5002A searches for a sync word, the receiver remaining enabled while preamble is detected. As soon as an enabled sync word is found the 'batch zero identify' mode is started.

If preamble is not found within one batch duration then the 'long fade recovery' mode is entered.

When in **batch zero detect** mode the PCD5002A switches on every batch to maintain synchronization and check for the batch zero identifier. Detection of the batch zero identifier activates the 'cycle receive' mode. When synchronization is lost the 'long fade recovery' mode is entered. 'preamble receive' mode is entered when preamble is detected.

In the **batch zero identify** mode the first code-word immediately after the sync word of the first batch is compared with the programmed batch zero identifier. Failure to detect the batch zero identifier will cause the device to enter the 'short fade recovery' mode.

When this comparison is successful the function bits determine whether any broadcast message will follow. Any function bit combination other than '1,1' will cause the PCD5002A to accept message code-words until terminated by a valid address code-word.

## Enhanced Pager Decoder for APOC1/POCSAG

## PCD5002A

After reception of any broadcast message data the PCD5002A continues to operate in the 'cycle receive' mode.

In the **cycle receive** mode the PCD5002A enables call reception in only one programmed batch per cycle. Sync word detection takes place from 2 bits before to 2 bits after the expected sync word position of this batch. If the sync word is not detected then the position of the current sync word will be maintained and the 'short fade recovery' mode will be entered.

When a valid sync word is found user address code-word detection takes place, as in normal POCSAG code. Any following message code-words are received normally. If a message extends into a subsequent batch containing a batch zero identifier, then the batch zero identifier is detected normally and message reception will continue.

Data reception is suspended after the programmed batch until the same batch position in the next cycle. The exception being when a received call continues into the next batch.

In the **short fade recovery** mode the programmed data receive batch will continue to be checked for user address code-words. In addition the first code-word after the programmed batch is checked for sync word or preamble.

When a valid sync word is detected the 'cycle receive' mode is re-entered, while detection of preamble causes the device to switch to the 'preamble receive' mode. When neither is found then the 'transmitter off' mode is entered.

In the **transmitter off** mode a time-out is set to a pre-programmed duration. This time-out corresponds to the maximum time between subsequent transmissions (preamble to preamble).

The PCD5002A then checks the first batch of every cycle for sync word or preamble. The programmed data receive batch is ignored (unless it is batch 0).

**Table 4** Synchronization window tolerance as a function of bit rate

| TIME FROM LOSS<br>OF SIGNAL | TOLERANCE       |                  |                  |
|-----------------------------|-----------------|------------------|------------------|
|                             | 512<br>(bits/s) | 1200<br>(bits/s) | 2400<br>(bits/s) |
| ≤30 s                       | 4 bits          | 4 bits           | 4 bits           |
| ≤60 s                       | 4 bits          | 4 bits           | 8 bits           |
| ≤120 s                      | 4 bits          | 8 bits           | 16 bits          |
| ≤240 s                      | 8 bits          | 16 bits          | 32 bits          |

Synchronization checking is performed over a window ranging from 'n' bits before to 'n' bits after the expected sync word position. The window tolerance 'n' depends on the time since the 'transmitter off' mode was entered and on the selected bit rate (see Table 4).

When a sync word is detected in this widened synchronization window the PCD5002A enters the 'batch zero identify' mode. Time-out expiry before a sync word has been detected causes the device to switch to the 'long fade recovery' mode.

Detection of preamble in the 'transmitter off' mode initiates the **preamble receive 2** mode. Operation in this mode is identical to 'preamble receive mode'. Failure to detect preamble for one batch period will cause the device to switch back to the 'transmitter off' mode. This prevents inadvertent loss of cycle synchronization due to spurious signals resembling preamble.

The **carrier detect** mode is identical to the 'carrier off' mode in standard POCSAG operation. Upon first entry the transmitter off time-out is started. The receiver is enabled to receive one code-word in every 18 code-words to check for sync word and preamble. This check is performed on the last available 32 bits for every received bit.

The 'preamble receive' mode is entered if preamble is detected. If a valid sync word is found the 'batch zero detect' mode is entered. If neither has been detected and the time-out expires, then the 'long fade recovery' mode is entered.

The **long fade recovery** mode is intended to quickly regain synchronization in fading conditions (not caused by the transmitter switching off between transmissions) or when having been out of range, while maintaining acceptable battery economy.

Initially, the receiver is switched off until one cycle duration after the last enabling in the 'transmitter off' mode. The receiver is then enabled for a 2 code-word period in which each contiguous group of 32 bits is tested for **any decodable** POCSAG code-word (including sync word) and preamble. Single-bit error correction is applied.

If a code-word is detected, the receiver enable period is extended by another code-word duration and the above test is repeated. This process continues while valid code-words are received.

## Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

Detection of preamble will cause the device to switch to the 'preamble receive' mode, while sync word detection will cause the device to switch to the 'batch zero detect' mode. When neither is detected during the 2 code-word window or any following 32-bit group, the receiver will be disabled.

If valid code-words are detected but no sync word or preamble is detected over a period of 18 code-words, the receiver is also disabled.

Data sampling, as previously described, is repeated one cycle duration after the moment the receiver was last activated.

### 8.15 Call termination

Call reception is terminated:

- Upon reception of any address code-word (including idle code-word but excluding the batch zero identifier in APOC1 operation) requiring no more than single bit error correction
- Upon reception of a correctable address code-word (error type other than '111'; see Table 11) that matches an enabled RIC
- When a forced call termination command is received from an external controller.
- In 'data fail' mode, when a sync word is not detected at the expected batch position.

The last method permits an external controller to stop call reception, depending on the number and type of errors which occurred in a call. After a forced call termination the decoder will enter the 'data fail' mode.

The type of error correction as well as the call termination conditions are indicated by status bits in the message data output.

In the event of the terminating code-word matching an enabled RIC, a concatenated call will be started with the call header replacing the terminator of the previous call.

Following call termination, transfer of the data received since the previous sync word period is initiated by an interrupt to the external controller.

### 8.16 Enhanced call termination

The PCD5002A provides an enhanced mode of call termination which is enabled by setting SPF byte 3, bit D7. When enabled, the following call termination conditions applies, in addition to those listed in Section 8.15.

- Reception of two consecutive code-words (excluding sync word), each of which are either uncorrectable or an address code-word with more than one bit in error.

### 8.17 Call data output format

POCSAG call information is stored in the decoder SRAM in blocks of 3 bytes per code-word. Each stored call consists of a call header, followed by message data blocks and a call terminator. In the event of concatenated messages the call terminator is replaced with the call header of the next message. An alert-only call only has a call header and a call terminator.

The formats of a call header, a message data block and a call terminator are shown in Tables 5, 7 and 9.

A **Call Header** contains information on the last sync word received, the RIC which began call reception and the type of error correction performed on the address code-word.

A **Message Data** block contains the data bits from a message code-word plus the type of error correction performed. No reformatting is performed on the data bits: numeric data appear as 4-bit groups per digit, alphanumeric data has a 7-bit ASCII representation.

The **Call Terminator** contains information on the last sync word received, information on the way the call was terminated (forced call termination command, loss of sync word in 'data fail' mode) and the type of error correction performed on the terminating code-word.

# Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

**Table 5** Call header format

| BYTE NUMBER | BIT 7 (MSB) | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 (LSB) |
|-------------|-------------|-------|-------|-------|-------|-------|-------|-------------|
| 1           | 0           | S3    | S2    | S1    | R3    | R2    | R1    | DF          |
| 2           | 0           | S3    | S2    | S1    | R3    | R2    | R1    | 0           |
| 3           | X           | X     | F0    | F1    | E3    | E2    | E1    | 0           |

**Table 6** Call header bit identification

| BITS (MSB TO LSB) | IDENTIFICATION                                                          |
|-------------------|-------------------------------------------------------------------------|
| S3 to S1          | identifier number of sync word for current batch (7 = standard POCSAG)  |
| R3 to R1          | identifier number of user address (RIC)                                 |
| DF                | data fail mode indication (1 = data fail mode); note 1                  |
| F0 and F1         | function bits of received address code-word (bits 20 and 21)            |
| E3 to E1          | detected error type; see Table 11; E3 = 0 in a concatenated call header |

**Note**

1. The DF bit in the call header is set:
  - a) When the sync word of the batch in which the (beginning of the) call was received, did not match the standard POCSAG or a user-programmed sync word. The sync word identifier (bits S3 to S1) will then be made 0.
  - b) When any code-word of a previous call received in the same batch was uncorrectable.

**Table 7** Message data format

| BYTE NUMBER | BIT 7 (MSB) | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 (LSB) |
|-------------|-------------|-------|-------|-------|-------|-------|-------|-------------|
| 1           | M2          | M3    | M4    | M5    | M6    | M7    | M8    | M9          |
| 2           | M10         | M11   | M12   | M13   | M14   | M15   | M16   | M17         |
| 3           | M18         | M19   | M20   | M21   | E3    | E2    | E1    | M1          |

**Table 8** Message data bit identification

| BITS (MSB TO LSB) | IDENTIFICATION                    |
|-------------------|-----------------------------------|
| M2 to M21         | message code-word data bits       |
| E3 to E1          | detected error type; see Table 11 |
| M1                | message code-word flag            |

**Table 9** Call terminator format

| BYTE NUMBER | BIT 7 (MSB) | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 (LSB) |
|-------------|-------------|-------|-------|-------|-------|-------|-------|-------------|
| 1           | FT          | S3    | S2    | S1    | 0     | 0     | 0     | DF          |
| 2           | FT          | S3    | S2    | S1    | 0     | 0     | 0     | X           |
| 3           | X           | X     | X     | X     | E3    | E2    | E1    | 0           |

## Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

**Table 10** Call terminator bit identification

| BITS (MSB TO LSB) | IDENTIFICATION                                                 |
|-------------------|----------------------------------------------------------------|
| FT                | forced call termination (1 = yes)                              |
| S3 to S1          | identifier number of last sync word                            |
| DF                | data fail mode indication (1 = data fail mode); note 1         |
| E3 to E1          | detected error type; see Table 11; E3 = 0 in a call terminator |

**Note**

1. The DF bit in the call terminator is set:
  - a) When any call data code-word in the terminating batch was uncorrectable, while in 'data receive' mode.
  - b) When the sync word at the start of the terminating batch did not match the standard POCSAG or a user-programmed sync word, while in 'data fail' mode.

**Table 11** Error type identification (note 1)

| E3 | E2 | E1 | ERROR TYPE                         | NUMBER OF ERRORS |
|----|----|----|------------------------------------|------------------|
| 0  | 0  | 0  | no errors; correct code-word       | 0                |
| 0  | 0  | 1  | parity bit in error                | 1                |
| 0  | 1  | 0  | single bit error                   | 1 + parity       |
| 0  | 1  | 1  | single bit error and parity error  | 1                |
| 1  | 0  | 0  | not used                           | –                |
| 1  | 0  | 1  | 4-bit burst error and parity error | 3 (e.g. 1101)    |
| 1  | 1  | 0  | 2-bit random error                 | 2                |
| 1  | 1  | 1  | uncorrectable code-word            | 3 or more        |

**Note**

1. POCSAG code allows a maximum of three bit errors to be detected per code-word.

**8.18 Error type indication**

Table 11 shows how the different types of detected errors are encoded in the call data output format.

**8.19 Data transfer**

Data transfer is initiated either during sync word periods or as soon as the receiver is disabled after call termination. If the SRAM buffer is full, data transfer is initiated immediately during the next code-word.

When the PCD5002A is ready to transfer received call data an external interrupt will be generated via output INT. Any message data can be read by accessing the RAM output register via the I<sup>2</sup>C-bus interface. Bytes will be output starting from the position indicated by the RAM read pointer.

Call termination can occur on reception of an address code-word (or even a message code-word if in Enhanced Call Termination Mode) or when a sync word is not

detected while in the 'Data Fail' mode ('Short Fade Recovery' in APOC1).

**8.20 Continuous data decoding**

Apart from transmissions in the POCSAG or APOC1 format, the PCD5002A is also capable of decoding continuous transmissions with the same code-word structure. Any User-Programmable Sync Word (UPSW) may be designated to enable continuous data decoding.

When a Continuous Data Decoding (CDD) sync word is detected at any sync word position, the receiver remains enabled from then on. Status bits D1 and D0 show the CDD mode to be active.

All code-words are decoded and their data fields are stored in SRAM. The usual error information is appended. No distinction is made between address and message code-words: code-word bit 0 is treated as a data bit and is stored in bit M1 of the 3-byte output format.

## Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

Code-words received at the expected sync word positions (POCSAG batch size) are matched against standard POCSAG sync word, all enabled UPSWs and preamble.

Data output to an external controller is initiated by an interrupt at the next sync word position, after reception of 16 code-words.

The call header preceding the data has a different structure from normal POCSAG or APOC1 data. The data header format is shown in Table 12.

Continuous data decoding continues until one of the following conditions occur:

- The decoder is switched to the OFF state
- A Forced Call Termination (FCT) command is received via the I<sup>2</sup>C-bus
- Preamble is detected at the sync word position
- Standard POCSAG sync word or an enabled non-CDD sync word is detected.

Only a forced call termination command will be indicated in the SRAM data by a call terminator. In the other events continuous data decoding will stop without notification.

Upon forced termination the 'fade recovery' mode is entered. Detection of preamble causes the device to switch to the 'preamble receive' mode. Detection of a standard sync word or any enabled non-continuous UPSW will cause the device to switch to the 'data receive' mode.

Continuous data decoding will continue in the next batch if any enabled CDD sync word is detected or no enabled sync word is detected. It should be noted that the enhanced call termination is ignored in CCD mode.

### 8.21 Receiver and oscillator control

A paging receiver and an RF oscillator circuit can be controlled independently via enable outputs RXE and ROE respectively. Their operating periods are optimized according to the synchronization mode of the decoder. Each enable signal has its own programmable establishment time (see Table 14).

**Table 12** Continuous data header format

| BYTE NUMBER | BIT 7 (MSB) | BIT 6 | BIT 5 | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 (LSB) |
|-------------|-------------|-------|-------|-------|-------|-------|-------|-------------|
| 1           | 0           | X     | X     | X     | C3    | C2    | C1    | 0           |
| 2           | 0           | C3    | C2    | C1    | C3    | C2    | C1    | 0           |
| 3           | X           | X     | F0    | F1    | E3    | E2    | E1    | 0           |

**Table 13** Data header bit identification

| BITS (MSB TO LSB) | IDENTIFICATION                                                           |
|-------------------|--------------------------------------------------------------------------|
| C3 to C1          | identifier number of continuous data decoding sync word                  |
| F0 and F1         | function bits of received address code-word (bits 20 and 21)             |
| E3 to E1          | detected error type (see Table 11); E3 = 0 in a concatenated call header |

**Table 14** Receiver and oscillator establishment times (note 1)

| CONTROL OUTPUT | ESTABLISHMENT TIME |    |    |    | UNIT |
|----------------|--------------------|----|----|----|------|
| RXE            | 5                  | 10 | 15 | 30 | ms   |
| ROE            | 20                 | 30 | 40 | 50 | ms   |

#### Note

1. The exact values may differ slightly from the above values, depending on the bit rate (see Table 25).

## Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

### 8.22 Demodulator quick charge

Two modes of operation are available that determine the period when the DQC output is set

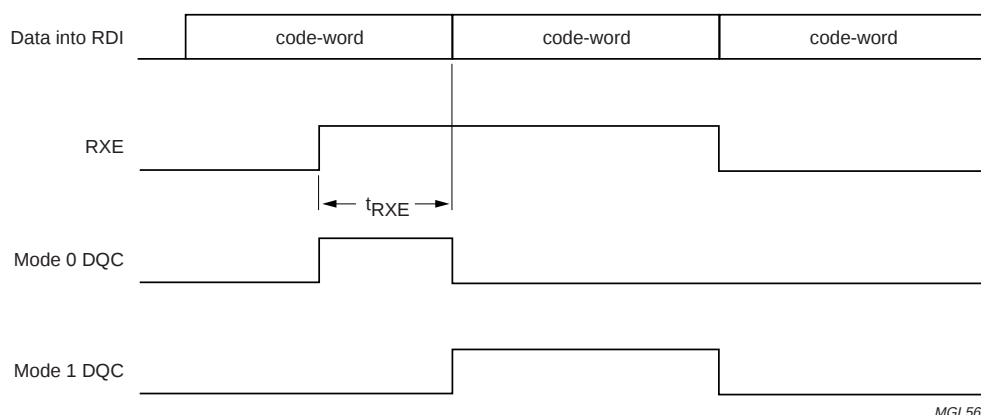
The operating mode is selected by EEPROM programming of SPF byte 03, bit D5:

- **Mode 0 (D5 = 0):** DQC is active HIGH during the receiver establishment time ( $t_{RXE}$ ) in all ACCESS and APOC1 modes except data receive and data fail (cycle receive and short fade recovery in APOC1). During switch-on, DQC is active for 1 code-word duration.
- **Mode 1 (D5 = 1):** DQC is active during sync word detection in all ACCESS and APOC1 modes. During switch-on and preamble receive modes, DQC is active continuously.

The timing of DQC is as follows (see Fig.6):

- **Mode 0:** Set along with RXE output (time  $t_{RXE}$  before the first code-word is expected); cleared during the second bit of the code-word following  $t_{RXE}$
- **Mode 1:** Set during the second bit of the sync word; cleared after the last bit of the sync word.

**Note:** During switch-on,  $t_{RXE}$  is not used: RXE and DQC are switched on immediately.



MGL566

Fig.6 DQC Timing.

## Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

### 8.23 External receiver control and monitoring

An external controller may enable the receiver control outputs continuously via an I<sup>2</sup>C-bus command, overruling the normal enable pattern. Data reception continues normally. This mode can be exited by means of a reset or an I<sup>2</sup>C-bus command.

External monitoring of the receiver control output RXE is possible via bit D6 in the status register, when enabled via the control register (D2 = 1). Each change of state of output RXE will generate an external interrupt at output INT.

### 8.24 Battery condition input

A logic signal from an external sense circuit, signalling battery condition, can be applied to the BAT input. This input is sampled each time the receiver is disabled (RXE ↓ 0).

When enabled via the control register (D2 = 0), the condition of input BAT is reflected in bit D6 of the status register. Each change of state of bit D6 causes an external interrupt at output INT.

When using the UAA2080 pager receiver a battery-low condition corresponds to a logic HIGH level. With a different sense circuit the reverse polarity can be used as well, because every change of state is signalled to an external controller.

After a reset the initial condition of the battery-low indicator in the status register is zero.

### 8.25 Synthesizer control

Control of an external frequency synthesizer is possible via a dedicated 3-line serial interface (outputs ZSD, ZSC and ZLE). This interface is common to a number of available synthesizers. The synthesizer is enabled using the oscillator enable output ROE.

The frequency parameters must be programmed in EEPROM. Two blocks of maximum 24 bits each can be stored. Any unused bits must be programmed at the beginning of a block: only the last bits are used by the synthesizer.

When the function is selected by SPF programming (SPF byte 1, bit D6), data is transferred to the synthesizer each time the PCD5002A is switched from the OFF to the ON status. Transfer takes place serially in two blocks, starting with bit 0 (MSB) of block 1 (see Table 28).

Data bits on ZSD change on the falling edges of ZSC. After clocking all bits into the synthesizer, a latch enable pulse copies the data to the internal divider registers. A timing diagram is illustrated in Fig.7.

The data output timing is synchronous, but has a pause in the bitstream of each block. This pause occurs in the 13th bit while ZSC is LOW. The nominal pause duration  $t_p$  depends on the programmed bit rate for data reception and is shown in Table 15. The total duration of the 13th bit is given by  $t_{ZCL} + t_p$ .

A similar pause occurs between the first and the second data block. The delay between the first latch enable pulse and the second data block is given by  $t_{ZDL2} + t_p$ .

The complete start-up timing of the synthesizer interface is illustrated in Fig.14.

**Table 15** Synthesizer programming pause

| BIT RATE (bits/s) | $t_p$ (CLOCKS) | $t_p$ (μs) |
|-------------------|----------------|------------|
| 512               | 119            | 1549       |
| 1200              | 33             | 430        |
| 2400              | 1              | 13         |

### 8.26 Serial microcontroller interface

The PCD5002A has an I<sup>2</sup>C-bus serial microcontroller interface capable of operating at 400 kbits/s.

The PCD5002A is a slave transceiver with a 7-bit I<sup>2</sup>C-bus address 39 (bits A6 to A0 = 0100111).

Data transmission requires 2 lines: SDA (data) and SCL (clock), each with an external pull-up resistor. The clock signal (SCL) for any data transmission must be generated by the external controlling device.

A transmission is initiated by a START condition (S: SCL = 1, SDA = ↓) and terminated by a STOP condition (P: SCL = 1, SDA = ↑).

Data bits must be stable when SCL is HIGH. If there are multiple transmissions, the STOP condition can be replaced with a new START condition.

Data is transferred on a byte basis, starting with a device address and a read/write indicator. Each transmitted byte must be followed by an acknowledge bit A (active LOW). If a receiving device is not ready to accept the next complete byte, it can force a bus wait state by holding SCL LOW.

The general I<sup>2</sup>C-bus transmission format is illustrated in Fig.6. Formats for master/slave communication are illustrated in Fig.9.

Enhanced Pager Decoder for  
APOC1/POCSAG

PCD5002A

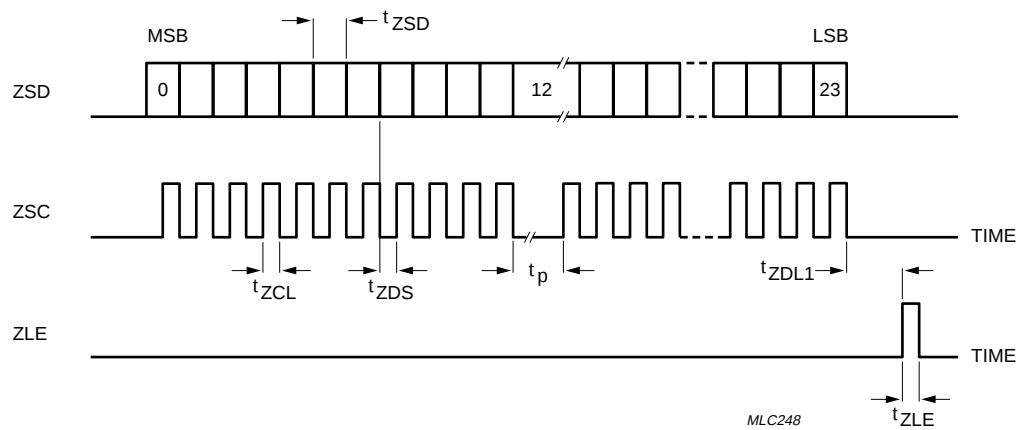


Fig.7 Synthesizer interface timing.

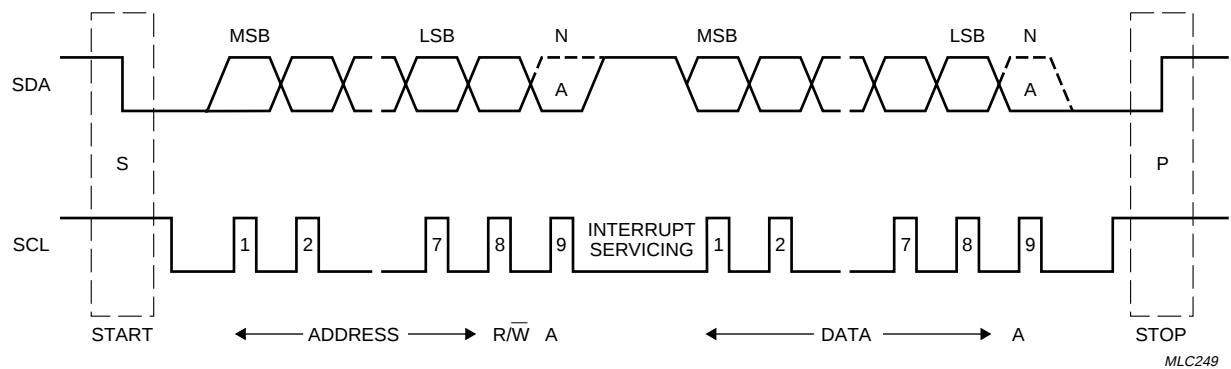
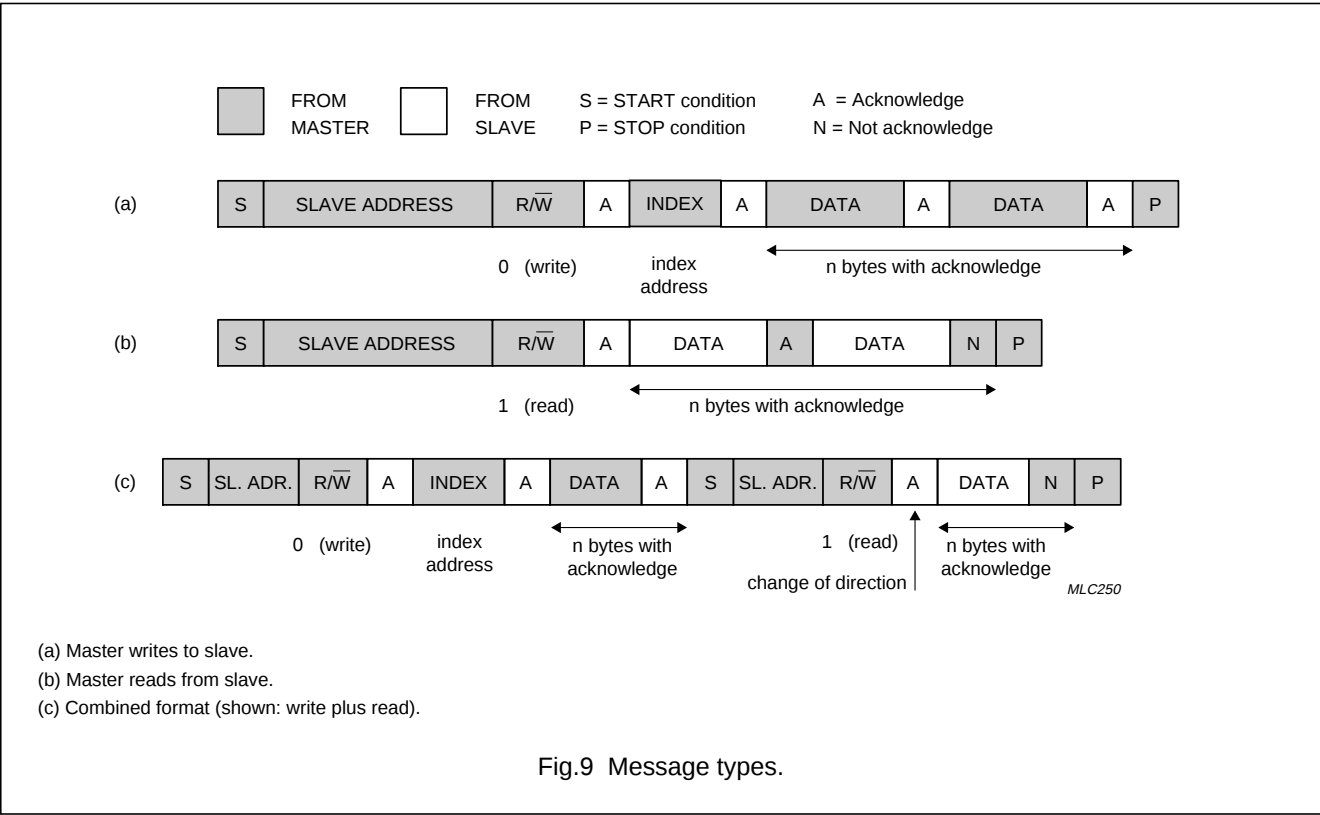


Fig.8 I<sup>2</sup>C-bus message format.

Enhanced Pager Decoder for  
APOC1/POCSAG

PCD5002A



**8.27 Decoder I<sup>2</sup>C-bus access**

All internal access to the PCD5002A takes place via the I<sup>2</sup>C-bus interface. For this purpose the internal registers, SRAM and EEPROM have been memory mapped and are accessed via an **index register**. Table 16 shows the index addresses of all internal blocks.

Registers are addressed directly, while RAM and EEPROM are addressed indirectly via address pointers and I/O registers.

**Remark:** The EEPROM memory map is non-contiguous and is organized as a matrix. The EEPROM address pointer contains both row and column indicators.

Data written to read-only bits will be ignored. Values read from write-only bits are undefined and must be ignored.

Each I<sup>2</sup>C-bus write message to the PCD5002A must start with its slave address, followed by the index address of the memory element to be accessed. An I<sup>2</sup>C-bus read message uses the last written index address as a data source. The different I<sup>2</sup>C-bus message types are shown in Fig.9.

As a slave the PCD5002A cannot initiate bus transfers by itself. To prevent an external controller from having to monitor the operating status of the decoder, all important events generate an external interrupt on output INT.

## Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

**Table 16** Index register

| ADDRESS <sup>(1)</sup> | REGISTER FUNCTION                       | ACCESS |
|------------------------|-----------------------------------------|--------|
| 00H                    | status                                  | R      |
| 00H                    | control                                 | W      |
| 01H                    | real-time clock: seconds                | R/W    |
| 02H                    | real-time clock: $\frac{1}{100}$ second | R/W    |
| 03H                    | alert cadence                           | W      |
| 04H                    | alert set-up                            | W      |
| 05H                    | periodic interrupt modulus              | W      |
| 05H                    | periodic interrupt counter              | R      |
| 06H                    | RAM write address pointer               | R      |
| 07H                    | EEPROM address pointer                  | R/W    |
| 08H                    | RAM read address pointer                | R/W    |
| 09H                    | RAM data output                         | R      |
| 0AH                    | EEPROM data input/output                | R/W    |
| 0BH to 0FH             | unused                                  | note 2 |

**Notes**

1. The index register only uses the least significant nibble, the upper 4 bits are ignored.
2. Writing to registers 0B to 0F has no effect, reading produces meaningless data.

**8.28 External interrupt**

The PCD5002A can signal events to an external controller via an interrupt signal at output INT. The interrupt polarity is programmable via SPF programming. The interrupt source is shown in the status register.

Interrupts are generated by the following events (more than one event is possible):

- Call data available for output (bit D2)
- SRAM pointers becoming equal (bit D3)
- Expiry of periodic time-out (bit D7)
- Expiry of alert time-out (bit D4)
- Change of state in out-of-range indicator (bit D5)
- Change of state in battery-low indicator or in receiver control output RXE (bit D6).

Immediate interrupts are generated by status bits D3, D4, D6 (RXE monitoring) and D7. Bits D2, D5 and D6 (BAT monitoring) generate interrupts as soon as the receiver is disabled (RXE = 0).

When call data is available (D2 = 1) but the receiver remains switched on, an interrupt is generated at the next sync word position, if data fail mode (short fade recovery mode in APOC1) is not active.

The interrupt output INT is reset after completion of a status read operation.

**8.29 Interrupt masking**

In the PCD5002A certain interrupts can be suppressed by masking via the control register. The following interrupts can be masked:

- **Out-of-Range (status bit D5):** change of state interrupt, masked by setting control register bit D5
- **BAT/RXE monitoring (status bit D6):** change of state interrupt (source selected by control register bit D2), masked by setting control register bit D6
- **Periodic Timer (status bit D7):** timer overflow interrupt, masked by setting control register bit D7.

Although no interrupts are generated by these conditions when masked via the control register, the corresponding status bits are updated normally and available via the status register. At reset the control register is cleared, causing all interrupts to be enabled.

## Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

### 8.30 Status/control register

The status/control register consists of two independent registers, one for reading (status) and one for writing (control).

The status register shows the current operating condition of the decoder and the cause(s) of an external interrupt. The control register activates/deactivates certain functions. Tables 17 and 18 show the bit allocations of both registers.

All status bits will be reset after a status read operation except for the out-of-range, battery-low and receiver enable indicator bits (see note 1 to Table 17).

**Table 17** Status register (00H; read)

| BIT <sup>(1)</sup> | VALUE | DESCRIPTION                                                      |
|--------------------|-------|------------------------------------------------------------------|
| D1 and D0          | 0 0   | no new call data                                                 |
|                    | 0 1   | new call received (POCSAG or APOC1)                              |
|                    | 1 0   | continuous decoding data available                               |
|                    | 1 1   | batch zero data available (APOC1)                                |
| D3 and D2          | 0 0   | no data to be read (default after reset)                         |
|                    | 0 1   | RAM read/write pointers different; data to be read               |
|                    | 1 0   | RAM read/write pointers equal; no more data to read              |
|                    | 1 1   | RAM buffer full or overflow                                      |
| D4                 | 1     | alert time-out expired                                           |
| D5                 | 1     | out-of-range                                                     |
| D6                 | 1     | BAT input HIGH or RXE output active (selected by control bit D2) |
| D7                 | 1     | periodic timer interrupt                                         |

#### Note

1. After a status read operation bits D3, D4 and D7 are always reset, bits D1 and D0 only when no second call is pending. D2 is reset when the RAM is empty (read and write pointers equal).

**Table 18** Control register (00H; write)

| BIT (MSB: D7) | VALUE | DESCRIPTION                                                     |
|---------------|-------|-----------------------------------------------------------------|
| D0            | 1     | forced call termination (automatically reset after termination) |
| D1            | 1     | EEPROM programming enable                                       |
| D2            | 0     | BAT input selected for monitoring (status bit D6)               |
|               | 1     | RXE output selected for monitoring (status bit D6)              |
| D3            | 1     | receiver continuously enabled (RXE = 1 and ROE = 1)             |
| D4            | 0     | decoder in OFF status (while DON = 0)                           |
|               | 1     | decoder in ON status                                            |
| D5            | 1     | out-of-range interrupt masked                                   |
| D6            | 1     | BAT/RXE monitor interrupt masked                                |
| D7            | 1     | Periodic Timer interrupt masked                                 |

## Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

### 8.31 Pending interrupts

A secondary status register is used for storing status bits of pending interrupts. This occurs:

- When a new call is received while the previous one was not yet acknowledged by reading the status register
- When an interrupt occurs during a status read operation.

After completion of the status read the primary register is loaded with the contents of the secondary register, which is then reset. An immediate interrupt is then generated, output INT becoming active 1 decoder clock cycle after it was reset following the status read.

**Remark:** In the event of multiple pending calls, only the status bits of the last call are retained.

### 8.32 Out-of-range indication

The out-of-range condition occurs when entering the 'fade recovery' or 'carrier off' mode in POCSAG, or 'transmitter off' or 'carrier detect' mode in APOC1. This condition is reflected in bit D5 of the status register. The out-of-range condition is reset when either preamble or a valid sync word is detected.

The out-of-range bit (D5) in the status register is updated each time the receiver is disabled (RXE ↓ 0). Every change of state in bit D5 generates an interrupt.

### 8.33 Real-time clock

The PCD5002A provides a periodic reference pulse at output REF. The frequency of this signal can be selected by SPF programming:

- 32768 Hz
- 50 Hz (square wave)
- 2 Hz
- $\frac{1}{60}$  Hz.

The 32768 Hz signal does not have a fixed period, it consists of 32 pulses distributed over 75 main oscillator cycles at 76.8 kHz. The timing is illustrated in Fig.16.

When programmed for  $\frac{1}{60}$  Hz (1 pulse per minute) the pulse at output REF is held off while the receiver is enabled.

Except for the 50 Hz frequency the pulse width  $t_{RFP}$  is equal to one decoder clock period.

The real-time clock counter runs continuously irrespective of the operating condition of the PCD5002A. It contains a **seconds register** (maximum 59) and a  **$\frac{1}{100}$  second register** (maximum 99), which can be read from or written

to via the I<sup>2</sup>C-bus. The bit allocation of both registers is shown in Tables 19 and 20.

**Table 19** Real-time clock; seconds register (01H; read/write)

| BIT (MSB D7) | VALUE | DESCRIPTION                                            |
|--------------|-------|--------------------------------------------------------|
| D0           | –     | 1 s                                                    |
| D1           | –     | 2 s                                                    |
| D2           | –     | 4 s                                                    |
| D3           | –     | 8 s                                                    |
| D4           | –     | 16 s                                                   |
| D5           | –     | 32 s                                                   |
| D6           | X     | not used: ignored when written; undetermined when read |
| D7           | X     | not used: ignored when written; undetermined when read |

**Table 20** Real-time clock;  $\frac{1}{100}$  second register (02H; read/write)

| BIT (MSB D7) | VALUE | DESCRIPTION                                            |
|--------------|-------|--------------------------------------------------------|
| D0           | –     | 0.01 s                                                 |
| D1           | –     | 0.02 s                                                 |
| D2           | –     | 0.04 s                                                 |
| D3           | –     | 0.08 s                                                 |
| D4           | –     | 0.16 s                                                 |
| D5           | –     | 0.32 s                                                 |
| D6           | –     | 0.64 s                                                 |
| D7           | X     | not used: ignored when written; undetermined when read |

### 8.34 Periodic interrupt

A periodic interrupt can be realised with the periodic interrupt counter. This 8-bit counter is incremented every  $\frac{1}{100}$  s and produces an interrupt when it reaches the value stored in the periodic interrupt modulus register. The counter register is then reset and counting continues.

Operation is started by writing a non-zero value to the modulus register. Writing a zero will stop interrupt generation immediately and will halt the periodic interrupt counter after 2.55 s.

The modulus register is write-only, the counter register is read only. Both registers have the same index address (05H).

Enhanced Pager Decoder for  
APOC1/POCSAG

PCD5002A

8.35 Received call delay

Call reception (detection of an enabled RIC) causes both the periodic interrupt modulus and the counter register to be reset.

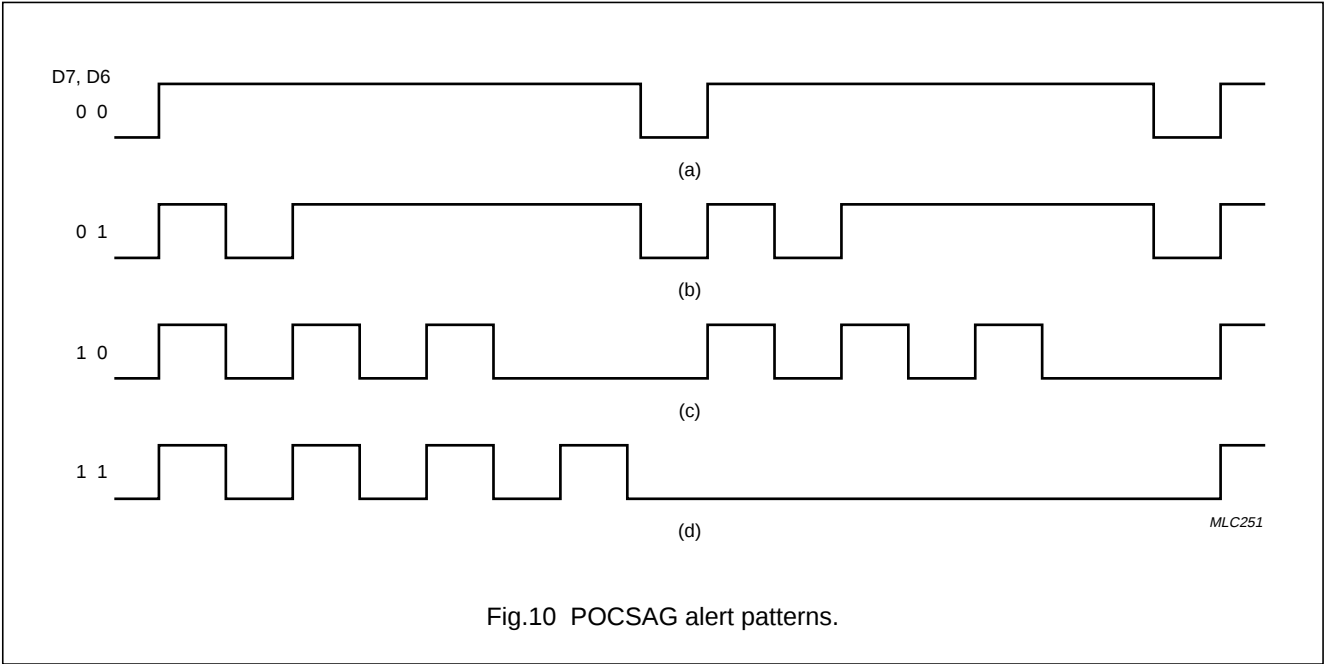
Since the periodic interrupt counter runs for another 2.55 s after a reset, the received call delay (in  $\frac{1}{100}$  s units) can be determined by reading the counter register.

Table 21 Alert set-up register (04H; write)

| BIT (MSB D7)             | VALUE | DESCRIPTION                                                                    |
|--------------------------|-------|--------------------------------------------------------------------------------|
| D0                       | 0     | call alert via cadence register                                                |
|                          | 1     | POCSAG call alert (pattern selected by D7 and D6)                              |
| D1                       | 0     | LOW level acoustic alert (ATL), pulsed vibrator alert (25 Hz)                  |
|                          | 1     | HIGH level acoustic alert (ATL + ATH), continuous vibrator alert               |
| D2                       | 0     | normal alerts (acoustic and LED)                                               |
|                          | 1     | warbled alerts: 16 Hz (LED: on/off, ATL/ATH: alternate $f_{AWH}$ , $f_{AWL}$ ) |
| D3                       | 1     | acoustic alerts enable (ATL, ATH)                                              |
| D4                       | 1     | vibrator alert enabled (VIB)                                                   |
| D5                       | 1     | LED alert enabled (LED)                                                        |
| D7 and D6 <sup>(1)</sup> | 0 0   | POCSAG alert pattern FC = 00; see Fig.10 (a)                                   |
|                          | 0 1   | POCSAG alert pattern FC = 01; see Fig.10 (b)                                   |
|                          | 1 0   | POCSAG alert pattern FC = 10; see Fig.10 (c)                                   |
|                          | 1 1   | POCSAG alert pattern FC = 11; see Fig.10 (d)                                   |

Note

1. Bits D7 and D6 correspond to function bits 20 and 21 respectively in the address code-word, which designate the POCSAG call type as shown in Table 1.



## Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

### 8.36 Alert generation

The PCD5002A is capable of controlling 3 different alert transducers, acoustic beeper (high and low level), LED and vibrator motor. The associated outputs are ATH/ATL, LED and VIB respectively. ATL is an open-drain output capable of directly driving an acoustic alerter via a resistor. The other outputs require external transistors.

Each alert output can be individually enabled via the alert set-up register. Alert level and warble can be separately selected. The alert pattern can either be standard POCSAG or determined via the alert cadence register. Direct alert control is possible via input ALC.

The alert set-up register is shown in Table 21.

Standard POCSAG alerts can be selected by setting bit D0 in the alert set-up register, bits D6 and D7 determining the alert pattern used.

### 8.37 Alert cadence register (03H; write)

When not programmed for POCSAG alerts (alert set-up register bit D0 = 0), the 8-bit alert cadence register determines the alert pattern. Each bit represents a 62.5 ms time slot, a logic 1 activating the enabled alert transducers. The bit pattern is rotated with the MSB (bit D7) being output first and the LSB (bit D0) last.

When the last time slot (bit D0) is initiated an interrupt is generated to allow loading of a new pattern. When the pattern is not changed it will be repeated. Writing a zero to the alert cadence register will halt alert generation within 62.5 ms.

### 8.38 Acoustic alert

Acoustic alerts are generated via outputs ATL and ATH. For LOW level alerts only ATL is active, while for HIGH level alerts ATH is also active. ATL is driven in counter phase with ATH.

The alert level is controlled by bit D1 in the alert set-up register.

When D1 is reset, for standard POCSAG alerts (D0 = 1) a LOW level acoustic alert is generated during the first 4 s (ATL), followed by 12 s at HIGH level (ATL + ATH). When D1 is set, the full 16 s are at HIGH level. An interrupt is generated after the full alert time has elapsed (indicated by bit D4 in the status register).

When using the alert cadence register, D1 would normally be updated by external control when the alert time-out interrupt occurs at the start of the 8th cadence time slot.

Since D1 acts immediately on the alert level, it is advisable to reset the last bit of the previous pattern to prevent unwanted audible level changes.

### 8.39 Vibrator alert

The vibrator output (VIB) is activated continuously during a standard POCSAG alert or whenever the alert cadence register is non-zero.

Two alert levels are supported, LOW level (25 Hz square wave) and HIGH level (continuous). The vibrator level is controlled by bit D1 in the alert set-up register.

### 8.40 LED alert

The LED output pattern corresponds either to the selected POCSAG alert or to the contents of the alert cadence register. No equivalent exists for HIGH/LOW level alerts.

### 8.41 Warbled alert

When enabled, by setting bit D2 in the alert set-up register, the signals on outputs ATL, ATH and LED are warbled with a 16 Hz modulation frequency. Output LED is switched on and off at the modulation rate, while outputs ATL and ATH switch between  $f_{AWH}$  and  $f_{AWL}$  alerter frequencies.

### 8.42 Direct alert control

A direct alert control input (ALC) is available for generating user alarm signals (e.g. battery-low warning). A HIGH level on input ALC activates all enabled alert outputs, overruling any ongoing alert patterns.

### 8.43 Alert priority

Generation of a standard POCSAG alert (D0 = 1) overrides any alert pattern in the alert cadence register. After completion of the standard alert, the original cadence is restarted from its last position. The alert set-up register will now contain the settings for the standard alert.

The highest priority has been assigned to the alert control input (ALC). All enabled alert outputs will be activated while ALC is set. Outputs are activated/deactivated in synchronism with the decoder clock. Activation requires an extra delay of 1 clock when no alerts are being generated.

When input ALC is reset, acoustic alerting does not cease until the current output frequency cycle has been completed.

## Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

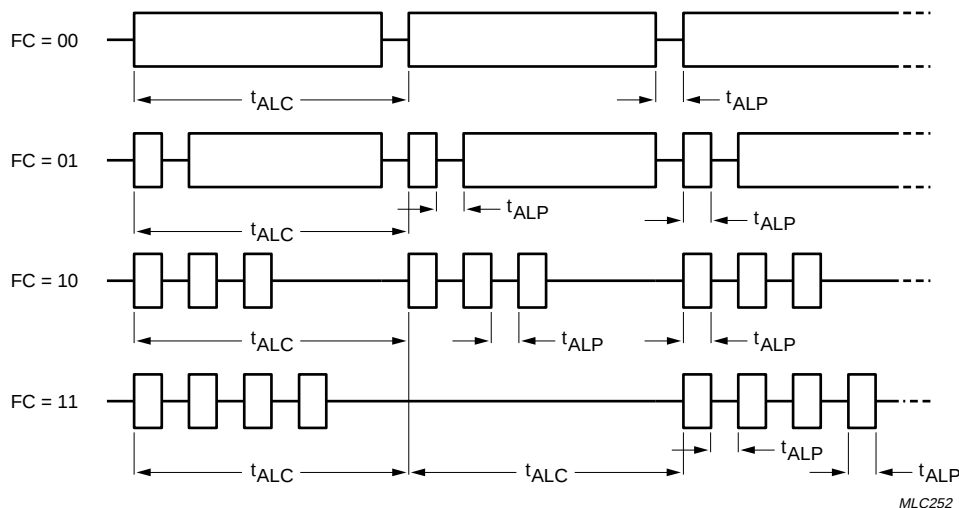


Fig.11 POCSAG alert timing.

### 8.44 Cancelling alerts

Standard POCSAG alerts (manual or automatic) are cancelled by resetting bit D0 in the alert set-up register. User defined alerts are cancelled by writing a zero to the alert cadence register. Any ongoing alert is cancelled when a reset pulse is applied to input RST.

### 8.45 Automatic POCSAG alerts

Standard alert patterns have been defined for each POCSAG call type, as indicated by the function bits in the address code-word (see Table 1). The timing of these alert patterns is shown in Fig.11. After completion of the full 16 s alert period an interrupt is generated by status bit D4.

When enabled by SPF programming (SPF byte 03, bit D2) standard POCSAG alerts will be automatically generated at outputs ATL, ATH, LED and VIB upon call reception. The alert pattern matches the call type as indicated by the function bits in the received address code-word.

The original settings of the alert set-up register will be lost. Bit D0 is reset after completion of the alert.

### 8.46 SRAM access

The on-chip SRAM can hold up to 96 bytes of call data. Each call consists of a call header (3 bytes), message data blocks (3 bytes per code-word) and a call terminator (3 bytes).

The RAM is filled by the decoder and can be read via the I<sup>2</sup>C-bus interface. The RAM is accessed indirectly by a read address pointer and a data output register. A write address pointer indicates the position of the last message byte stored.

Status register bit D2 is set when the read and write pointers are different. It is reset only when the SRAM pointers become equal during reading, i.e. when the RAM becomes empty.

Status bit D3 is set when the read and write pointers become equal. This can be due to a RAM empty or a RAM full condition. It is reset after a status read operation.

Interrupts are generated as follows:

- When status bit D2 is set and the receiver is disabled (RXE = 0); data is available for reading, if data fail mode (short fade recovery mode in APOC1) is not active
- Immediately when status bit D3 is set: RAM is either empty (status bit D2 = 0) or full (status bit D2 = 1).

To avoid loss of data due to RAM overflow at least 3 bytes of data must be read during reception of the code-word following the 'RAM full' interrupt.

## Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

### 8.47 RAM write address pointer (06H; read)

The RAM write address pointer is automatically incremented during call reception, because the decoder writes each data byte to RAM. The RAM write address pointer can only be read. Values range from 00H to 5FH. Bit D7 (MSB) is not used and its value is undefined when read. When a call data byte is written to location 5FH, the write address pointer wraps around to 00H. This does not necessarily imply a RAM full condition.

### 8.48 RAM read address pointer (08H; read/write)

The RAM read address pointer is automatically incremented after reading a data byte via the RAM output register.

The RAM read address pointer can be accessed for reading and writing.

The values range from 00H to 5FH. When at 5FH a read operation will cause wrapping around to 00H. Bit D7 (MSB) is not used; it is ignored when written to and undefined when read from.

### 8.49 RAM data output register (09H; read)

The RAM data output register contains the byte addressed by the RAM read address pointer and can only be read. Each read operation causes an increment of the RAM read address pointer.

### 8.50 EEPROM access

The EEPROM is intended for storage of user addresses (RICs), sync words and special programmed function (SPF) bits representing the decoder configuration.

The EEPROM can store 48 bytes of information and is organized as a matrix of 8 rows by 6 columns. The EEPROM is accessed indirectly via an address pointer and a data I/O register.

The EEPROM is protected against inadvertent writing by means of the programming enable bit in the control register (bit D1).

The EEPROM memory map is non-contiguous. Figure 12 shows both the EEPROM organization and the access method.

Identifier locations contain RICs or sync words. A total of 20 unassigned bytes are available for general purpose storage.

### 8.51 EEPROM address pointer (07H; read/write)

An EEPROM location is addressed via the EEPROM address pointer. It is incremented automatically each time a byte is read from or written to via the EEPROM data I/O register.

The EEPROM address pointer contains two counters for the row and the column number. Bits D2 to D0 contain the column number (0 to 5) and bits D5 to D3 the row number (0 to 7). Bits D7 and D6 of the address pointer are not used. Data written to these bits will be ignored, while their values are undefined when read.

The column and row counters are connected in series. Upon overflow of the column counter (column = 5) the row counter is automatically incremented and the column counter wraps to 0. On overflow the row counter wraps from 7 to 0.

### 8.52 EEPROM data I/O register (0AH; read/write)

The byte addressed by the EEPROM address pointer can be written to or read from via the EEPROM data I/O register. Each access automatically increments the EEPROM address pointer.

### 8.53 EEPROM access limitations

Since the EEPROM address pointer is used during data decoding, the EEPROM may not be accessed while the receiver is active (RXE = 1). It is advisable to switch to the OFF state before accessing the EEPROM.

The EEPROM cannot be written to unless the EEPROM programming enable bit (bit D1) in the control register is set.

For writing a minimum programming supply voltage ( $V_{DD(prog)}$ ) is required (2.0 V typ.). The programming supply current ( $I_{DD(prog)}$ ) required during writing is approximately 500  $\mu$ A.

### 8.54 EEPROM read operation

EEPROM read operations must start at a valid address in the non-contiguous memory map. Single byte or block reads are permitted.

### 8.55 EEPROM write operation

EEPROM write operations must always take place in blocks of 6 bytes, starting at the beginning of a row. Programming a single byte will reset the other bytes in the same row. Modifying a single byte in a row requires re-writing the unchanged bytes with their old contents.

Enhanced Pager Decoder for  
APOC1/POCSAG

PCD5002A

After writing each block a pause of 7.5 ms (max.) is required to complete the internal programming operation. During this time the external microcontroller may generate an I<sup>2</sup>C-bus STOP condition. If another I<sup>2</sup>C-bus transfer is initiated the decoder will pull SCL LOW during this pause.

After writing the EEPROM programming enable bit (D1) in, the control register must be reset.

8.56 Invalid write address

When an invalid write address is used, the column counter bits (D2 to D0) are forced to zero before being loaded into the address pointer. The row counter bits are used normally.

8.57 Incomplete programming sequence

A programming sequence may be aborted by an I<sup>2</sup>C-bus STOP condition. The EEPROM programming enable bit (D1) in the control register must then be reset.

Any bytes received from the last 6-byte block will be ignored and the contents of this (incomplete) EEPROM block will remain unchanged.

8.58 Unused EEPROM locations

A total of 20 EEPROM bytes are available for general purpose storage (see Table 22).

Table 22 Unused EEPROM addresses

| ROW | HEX                      |
|-----|--------------------------|
| 0   | 04 and 05 <sup>(1)</sup> |
| 5   | 28 to 2D                 |
| 6   | 30 to 35                 |
| 7   | 38 to 3D                 |

Note

- When using bytes 04H and 05H, care must be taken to preserve the SPF information stored in bytes 00H to 03H.

8.59 Special programmed function allocation

The SPF bit allocation in the EEPROM is shown in Tables 23 to 27. The SPF bits are located in row 0 of the EEPROM and occupy 4 bytes.

Bytes 04H and 05H are not used and are available for general purpose storage.

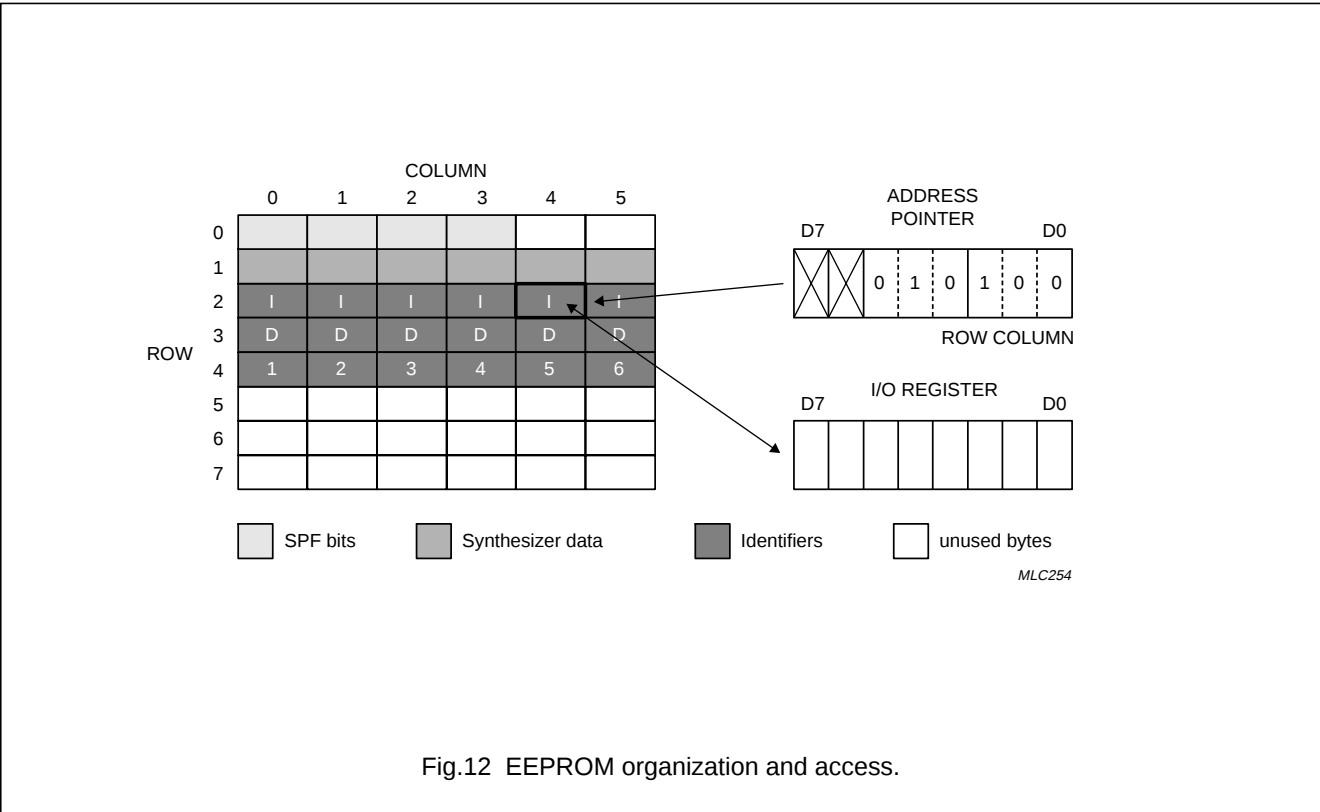


Fig.12 EEPROM organization and access.

## Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

**Table 23** Special programmed functions (EEPROM address 00H)

| BIT (MSB: D7)     | VALUE   | DESCRIPTION                           |
|-------------------|---------|---------------------------------------|
| D0                | 0       | POCSAG decoding enabled               |
|                   | 1       | APOC1 decoding enabled                |
| D1                | 0       | cycle length: 5 batches               |
|                   | 1       | cycle length: 15 batches              |
| D5 to D2 (MSB D5) | 0 to 4  | batch number (D1 = 0; MSB is ignored) |
|                   | 0 to 14 | batch number (D1 = 1)                 |
| D6                | 1       | continuous data decoding enabled      |
| D7                | 1       | received data inversion enabled       |

**Table 24** Special programmed functions (EEPROM address 01H)

| BIT (MSB: D7) | VALUE | DESCRIPTION                                              |
|---------------|-------|----------------------------------------------------------|
| D1 and D0     | 0 0   | 5 ms receiver establishment time (nominal); note 1       |
|               | 0 1   | 10 ms receiver establishment time (nominal); note 1      |
|               | 1 0   | 15 ms receiver establishment time (nominal); note 1      |
|               | 1 1   | 30 ms receiver establishment time (nominal); note 1      |
| D3 and D2     | 0 0   | 20 ms oscillator establishment time (nominal); note 1    |
|               | 0 1   | 30 ms oscillator establishment time (nominal); note 1    |
|               | 1 0   | 40 ms oscillator establishment time (nominal); note 1    |
|               | 1 1   | 50 ms oscillator establishment time (nominal); note 1    |
| D5 and D4     | 0 0   | 512 bits/s received bit rate                             |
|               | 0 1   | 1024 bits/s (not used in POCSAG)                         |
|               | 1 0   | 1200 bits/s                                              |
|               | 1 1   | 2400 bits/s                                              |
| D6            | 1     | synthesizer interface enabled (programming at switch-on) |
| D7            | 1     | voltage converter enabled                                |

**Note**

1. Since the exact establishment time is related to the programmed bit rate, Table 25 shows the values for the various bit rates.

# Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

**Table 25** Establishment time as a function of bit rate

| NOMINAL<br>ESTABLISHMENT<br>TIME | ACTUAL ESTABLISHMENT TIME |                   |                   |                    |
|----------------------------------|---------------------------|-------------------|-------------------|--------------------|
|                                  | 512 (bits/s)              | 1024 (bits/s)     | 1200 (bits/s)     | 2400 (bits/s)      |
| 5 ms                             | 5.9 ms (3 bits)           | 5.9 ms (6 bits)   | 5 ms (6 bits)     | 5 ms (12 bits)     |
| 10 ms                            | 11.7 ms (6 bits)          | 11.7 ms (12 bits) | 10 ms (12 bits)   | 10 ms (24 bits)    |
| 15 ms                            | 15.6 ms (8 bits)          | 15.6 ms (16 bits) | 16.7 ms (20 bits) | 16.7 ms (40 bits)  |
| 20 ms                            | 23.4 ms (12 bits)         | 23.4 ms (24 bits) | 20 ms (24 bits)   | 20 ms (48 bits)    |
| 30 ms                            | 31.2 ms (16 bits)         | 31.2 ms (32 bits) | 26.7 ms (32 bits) | 26.7 ms (64 bits)  |
| 40 ms                            | 39.1 ms (20 bits)         | 39.1 ms (40 bits) | 40 ms (48 bits)   | 40 ms (96 bits)    |
| 50 ms                            | 46.9 ms (24 bits)         | 46.9 ms (48 bits) | 53.3 ms (64 bits) | 53.3 ms (128 bits) |

**Table 26** Special programmed functions (EEPROM address 02H)

| BIT (MSB: D7) | VALUE | DESCRIPTION                                    |
|---------------|-------|------------------------------------------------|
| D0            | X     | not used                                       |
| D1            | X     | not used                                       |
| D3 and D2     | 0 0   | 32 768 Hz real-time clock reference            |
|               | 0 1   | 50 Hz square wave                              |
|               | 1 0   | 2 Hz                                           |
|               | 1 1   | $\frac{1}{60}$ Hz                              |
| D4            | 1     | signal test mode enabled (REF and INT outputs) |
| D5            | 0     | burst error correction enabled                 |
| D7 and D6     | 0 0   | 30 s (+0.5 s max.) transmitter off time-out    |
|               | 0 1   | 60 s (+ 1 s max.) transmitter off time-out     |
|               | 1 0   | 120 s (+ 2 s max.) transmitter off time-out    |
|               | 1 1   | 240 s (+ 4 s max.) transmitter off time-out    |

**Table 27** Special programmed functions (EEPROM address 03H)

| BIT (MSB: D7) | VALUE | DESCRIPTION                               |
|---------------|-------|-------------------------------------------|
| D1 and D0     | 0 0   | 2048 Hz acoustic alerter frequency        |
|               | 0 1   | 2731 Hz acoustic alerter frequency        |
|               | 1 0   | 4096 Hz acoustic alerter frequency        |
|               | 1 1   | 3200 Hz acoustic alerter frequency        |
| D2            | 1     | automatic POCSAG alert generation enabled |
| D3            | X     | not used                                  |
| D4            | X     | not used                                  |
| D5            | 0     | DQC mode 0                                |
|               | 1     | DQC mode 1                                |
| D6            | 0     | INT output polarity: active LOW           |
|               | 1     | INT output polarity: active HIGH          |
| D7            | 0     | standard call termination                 |
|               | 1     | enhanced call termination                 |

## Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

### 8.60 Synthesizer programming data

Data for programming a PLL synthesizer via pins ZSD, ZSC and ZLE can be stored in row 1 of the EEPROM. Six bytes are available starting with address 08H.

Data is transferred in two serial blocks of 24 bits each, starting with bit 0 (MSB) of block 1. Any unused bits must be programmed at the beginning of a block.

**Table 28** Synthesizer programming data (EEPROM address 08H to 0DH)

| ADDRESS (HEX) | BIT (MSB: D7) | DESCRIPTION                                |
|---------------|---------------|--------------------------------------------|
| 08            | D7 to D0      | bits 0 to 7 of data block 1 (bit 0 is MSB) |
| 09            | D7 to D0      | bits 8 to 15                               |
| 0A            | D7 to D0      | bits 16 to 23                              |
| 0B            | D7 to D0      | bits 0 to 7 of data block 2 (bit 0 is MSB) |
| 0C            | D7 to D0      | bits 8 to 15                               |
| 0D            | D7 to D0      | bits 16 to 23                              |

### 8.61 Identifier storage allocation

Up to 6 different identifiers can be stored in EEPROM for matching with incoming data. The PCD5002A can distinguish two types of identifiers:

- User addresses (RIC)
- User Programmable Sync Words (UPSW)
- Batch zero identifiers
- Continuous Data Decoding (CDD) sync words.

**Table 29** Identifier storage allocation (EEPROM address 10H to 25H)

| ADDRESS (HEX) | BYTE | DESCRIPTION              |
|---------------|------|--------------------------|
| 10 to 15      | 1    | identifier number 1 to 6 |
| 18 to 1D      | 2    | identifier number 1 to 6 |
| 20 to 25      | 3    | identifier number 1 to 6 |

Identifiers are stored in EEPROM rows 2, 3 and 4. Each identifier location consists of 3 bytes in the same column. The identifier number is equal to the column number + 1.

Each identifier can be individually enabled. The standard POCSAG sync word is always enabled and has identifier number 7.

The identifier type is determined by bits D2 and D0 of identifier byte 3, as shown in Table 31.

Identifiers 1 and 2 always represent RICs or batch zero identifiers. The last 4 identifiers (numbers 3 to 6) can represent any identifier type.

A UPSW represents an unused address and must differ by more than 6 bits from preamble to guarantee detection.

A batch zero identifier marks the start of a new cycle in the APOC1 protocol. It is only recognized when APOC1 decoding has been enabled (SPF byte 00, bit D0).

Reception of a CDD sync word initiates continuous data decoding. CDD sync words are only recognized when continuous data decoding has been enabled (SPF byte 00, bit 6).

Table 29 shows the memory locations of the 6 identifiers. The bit allocation per identifier is given in Table 30.

## Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

**Table 30** Identifier bit allocation

| BYTE | BIT (MSB: D7) | DESCRIPTION                                                  |
|------|---------------|--------------------------------------------------------------|
| 1    | D7 to D0      | bits 2 to 9 of POCSAG code-word (RIC or UPSW); notes 1 and 2 |
| 2    | D7 to D0      | bits 10 to 17                                                |
| 3    | D7 and D6     | bits 18 and 19                                               |
|      | D5            | frame number bit FR3 (RIC); note 3                           |
|      | D4            | frame number bit FR2 (RIC)                                   |
|      | D3            | frame number bit FR1 (RIC)                                   |
|      | D2            | identifier type selection (0 = UPSW, 1 = RIC); note 4        |
|      | D1            | identifier enable (1 = enabled)                              |
|      | D0            | batch zero ID/continuous decoding (1 = enabled)              |

**Notes**

1. The bit numbering corresponds with the numbering in a POCSAG code-word; bit 1 is the flag bit (0 = address, 1 = message).
2. A UPSW needs 18 bits to be matched for successful identification. Bit 1 (MSB) must be logic 0. Bits 2 to 19 contain the identifier bit pattern, they are followed by 2 predetermined random (function) bits and the UPSW is completed by 10 CRC error correction bits and an even-parity bit.
3. Bits FR3 to FR1 (MSB: FR3) contain the 3 least significant bits of the 21-bit RIC.
4. Identifiers 1 and 2 (RIC only) will be disabled by programming bit D2 as logic 0.

**Table 31** Identifier types

| BYTE 3; BIT D2 | BYTE 3; BIT D0 | DESCRIPTION                        |
|----------------|----------------|------------------------------------|
| 0              | 0              | user programmable sync word        |
| 0              | 1              | continuous data decoding sync word |
| 1              | 0              | normal user address (RIC)          |
| 1              | 1              | batch zero identifier              |

**8.62 Voltage doubler**

An on-chip voltage doubler provides an unregulated DC output for supplying an LCD or a low power microcontroller at output  $V_{PO}$ . An external ceramic capacitor of 100 nF (typ.) is required between pins CCN and CCP. The voltage doubler is enabled via SPF programming.

**8.63 Level-shifted interface**

All interface lines are suited for communication with a microcontroller operating from a higher supply voltage. The external device must have a common reference at  $V_{SS}$  of the PCD5002A.

The reference voltage for the level-shifted interface must be applied to input  $V_{PR}$ . If required this could be the on-chip voltage doubler output  $V_{PO}$ . When the microcontroller has a separate (regulated) supply it should be connected to  $V_{PR}$ .

The level-shifted interface lines are RST, DON, ALC, REF and INT.

The I<sup>2</sup>C-bus interface lines SDA and SCL can be level-shifted independently of  $V_{PR}$  by the standard external pull-up resistors.

**8.64 Signal test mode**

A special 'signal test' mode is available for monitoring the performance of a receiver circuit together with the front-end of the PCD5002A.

For this purpose the output of the digital noise filter and the recovered bit clock are made available at outputs REF and INT respectively. All synchronization and decoding functions are normally active.

The 'signal test' mode is activated/deactivated by SPF programming.

## Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

### 9 OPERATING INSTRUCTIONS

#### 9.1 Reset conditions

When the PCD5002A is reset by applying a HIGH level to input RST, the condition of the decoder is as follows:

- OFF status (irrespective of DON input level)
- REF output frequency 32768 Hz
- All internal counters reset
- Status/control register reset
- All interrupts enabled
- No alert transducers selected
- LED, VIB and ATH outputs at LOW level
- ATL output high-impedance
- SDA and SCL inputs high-impedance
- Voltage converter disabled.

The programmed functions are activated within  $t_{RSU}$  after release of the reset condition (RST LOW). The settings affecting the external operation of the PCD5002A are as follows:

- REF output frequency
- Voltage converter
- INT output polarity
- Signal test mode.

When input DON is HIGH, the decoder starts operating in ON status immediately following  $t_{RSU}$ .

#### 9.2 Power-on reset circuit

During power-up of the PCD5002A a HIGH level of minimum duration  $t_{RST} = 50 \mu s$  must be applied to pin RST. This is to prevent EEPROM corruption which might otherwise occur because of the undefined contents of the control register.

The reset signal can be applied by the external microcontroller or by an RC power-on reset circuit on pin RST (C to  $V_{PR}$ , R to  $V_{SS}$ ). Such an RC-circuit should have a time constant of at least  $3t_{RST} = 150 \mu s$ .

Input RST has an internal high-ohmic pull-down resistor (nominal 2 M $\Omega$  at 2.5 V supply) which could be used together with a suitable external capacitor connected to  $V_{PR}$  to create a power-on reset signal. However, since this pull-down resistor varies considerably with processing and supply voltage, the resulting time constant is inaccurate.

A more accurate reset duration can be realised with an additional external resistor connected to  $V_{SS}$ .

Recommended minimum values in this case are  $C = 2.2 \text{ nF}$  and  $R = 100 \text{ k}\Omega$  (see Fig.17).

#### 9.3 Reset timing

The start-up time for the crystal oscillator may exceed 1 s (typ. 800 ms). It is advisable to apply a reset condition, at least during the first part of this period. The minimum reset pulse duration  $t_{RST}$  is 50  $\mu s$ .

During reset the oscillator is active, but clock signals are inhibited internally. Once the reset condition is released the end of the oscillator start-up period can be detected by a rising edge on output INT.

During a reset the voltage converter clock ( $V_{clk}$ ) is held at zero. The resulting output voltage drop may cause problems when the external resetting device is powered by the internal voltage doubler. A sufficiently large buffer capacitor connected between output  $V_{PO}$  and  $V_{SS}$  must be provided to supply the microcontroller during reset. The voltage at  $V_{PO}$  will not drop below  $V_{DD} - 0.7 \text{ V}$ .

Immediately after a reset all programmable internal functions will start operating according to a programmed value of 0. During the first 8 full clock cycles ( $t_{RSU}$ ) all programmed values are loaded from EEPROM.

After reset the receiver outputs RXE and ROE become active immediately, if DON is HIGH and the synthesizer is disabled. When the synthesizer is enabled, RXE and ROE will only become active after the second pulse on ZLE completes the loading of synthesizer data.

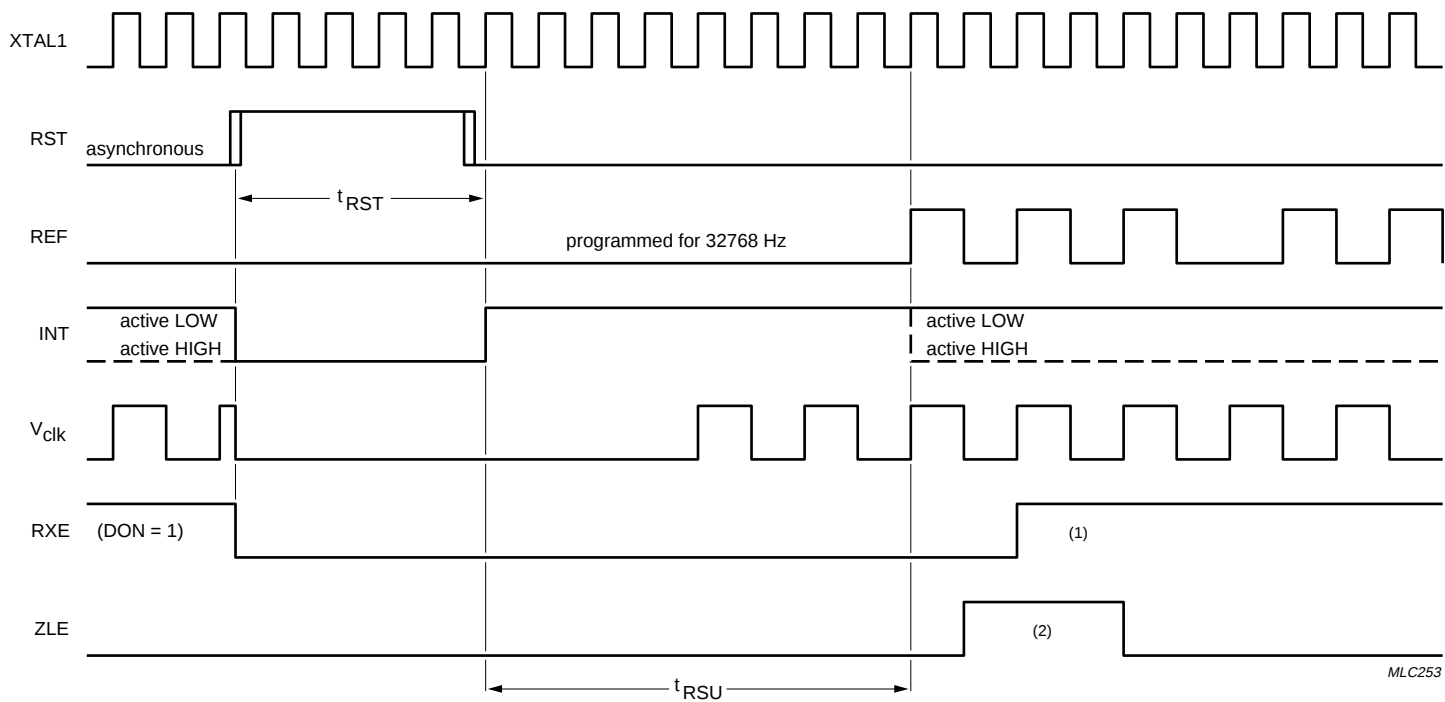
The full reset timing is illustrated in Fig.13. The start-up timing including synthesizer programming is illustrated in Fig.14.

#### 9.4 Initial programming

A newly-delivered PCD5002A has EEPROM contents which are undefined. The EEPROM should therefore be programmed, followed by a reset to activate the SPF settings, before any attempt is made to use the device.

Enhanced Pager Decoder for  
APOC1/POCSAG

PCD5002A



- (1) The RXE output signal is shown for disabled synthesizer. When the synthesizer is enabled RXE is held off until after the second pulse on ZLE (programming complete).
- (2) The ZLE output signal is shown for enabled synthesizer and DON = 1. When DON = 0 output ZLE remains HIGH until ON state is entered (DON = 1 or control register bit D4 = 1).

Fig.13 Reset timing.

Enhanced Pager Decoder for  
APOC1/POCSAG

PCD5002A

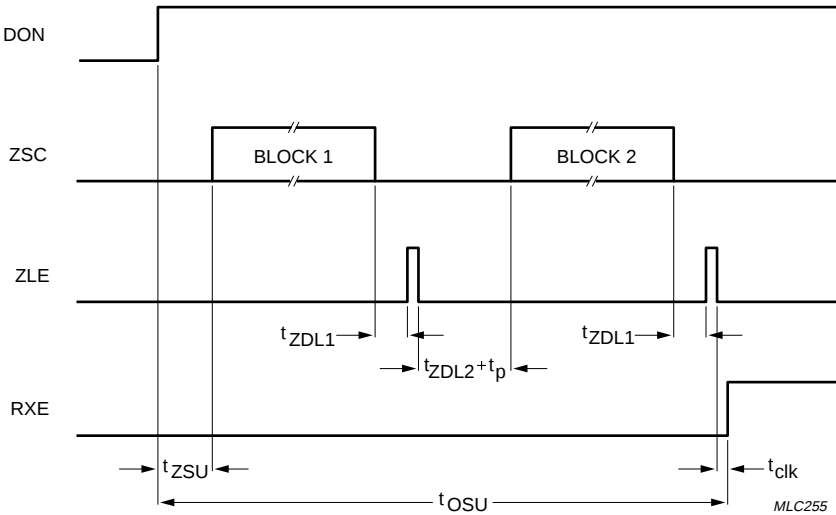


Fig.14 Start-up timing including synthesizer programming.

10 LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL    | PARAMETER                                  | CONDITIONS                           | MIN.           | MAX.           | UNIT |
|-----------|--------------------------------------------|--------------------------------------|----------------|----------------|------|
| $V_{DD}$  | supply voltage                             |                                      | -0.5           | +7.0           | V    |
| $V_{PR}$  | external reference voltage input           | $V_{PR} \geq V_{DD} - 0.8 \text{ V}$ | -0.5           | +7.0           | V    |
| $V_n$     | voltage on pins ALC, DON, RST, SDA and SCL | $V_n \leq 7.0 \text{ V}$             | $V_{SS} - 0.8$ | $V_{PR} + 0.8$ | V    |
| $V_{n1}$  | input voltage on any other pin             | $V_{n1} \leq 7.0 \text{ V}$          | $V_{SS} - 0.8$ | $V_{DD} + 0.8$ | V    |
| $P_{tot}$ | total power dissipation                    |                                      | -              | 250            | mW   |
| $P_{out}$ | power dissipation per output               |                                      | -              | 100            | mW   |
| $T_{amb}$ | operating ambient temperature              |                                      | -25            | +70            | °C   |
| $T_{stg}$ | storage temperature                        |                                      | -55            | +125           | °C   |

# Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

## 11 DC CHARACTERISTICS

$V_{DD} = 2.7\text{ V}$ ;  $V_{PR} = 2.7\text{ V}$ ;  $V_{SS} = 0\text{ V}$ ;  $T_{amb} = -25\text{ to }+70\text{ }^{\circ}\text{C}$ ; unless otherwise specified.

| SYMBOL                | PARAMETER                                                                                                         | CONDITIONS                                                 | MIN.               | TYP. | MAX.               | UNIT |
|-----------------------|-------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------|--------------------|------|--------------------|------|
| Supplies              |                                                                                                                   |                                                            |                    |      |                    |      |
| V <sub>DD</sub>       | supply voltage                                                                                                    | voltage converter disabled                                 | 1.5                | 2.7  | 6.0                | V    |
| V <sub>PR</sub>       | external reference voltage input                                                                                  | V <sub>PR</sub> ≥ V <sub>DD</sub> – 0.8 V                  | 1.5                | 2.7  | 6.0                | V    |
| V <sub>DD(prog)</sub> | programming supply voltage                                                                                        | voltage converter disabled                                 | 2.0                | –    | 6.0                | V    |
|                       |                                                                                                                   | voltage converter enabled                                  | 2.0                | –    | 3.0                | V    |
| I <sub>DD0</sub>      | supply current (OFF)                                                                                              | note 1                                                     | –                  | 25.0 | 40.0               | μA   |
| I <sub>DD1</sub>      | supply current (ON)                                                                                               | note 1; DON = V <sub>DD</sub>                              | –                  | 50.0 | 80.0               | μA   |
| I <sub>DD(prog)</sub> | programming supply current                                                                                        |                                                            | –                  | –    | 800                | μA   |
| Inputs                |                                                                                                                   |                                                            |                    |      |                    |      |
| V <sub>IL</sub>       | LOW-level input voltage pins<br>RDI and BAT<br>DON, ALC and RST<br>SDA and SCL                                    |                                                            | V <sub>SS</sub>    | –    | 0.3V <sub>DD</sub> | V    |
|                       |                                                                                                                   |                                                            | V <sub>SS</sub>    | –    | 0.3V <sub>PR</sub> | V    |
|                       |                                                                                                                   |                                                            | V <sub>SS</sub>    | –    | 0.3V <sub>DD</sub> | V    |
| V <sub>IH</sub>       | HIGH-level input voltage pins<br>RDI and BAT<br>DON, ALC and RST<br>SDA and SCL                                   |                                                            | 0.7V <sub>DD</sub> | –    | V <sub>DD</sub>    | V    |
|                       |                                                                                                                   |                                                            | 0.7V <sub>PR</sub> | –    | V <sub>PR</sub>    | V    |
|                       |                                                                                                                   |                                                            | 0.7V <sub>DD</sub> | –    | V <sub>PR</sub>    | V    |
| I <sub>IL</sub>       | LOW-level input current pins<br>RDI, BAT, TS1, TS2, DON,<br>ALC and RST                                           | T <sub>amb</sub> = 25 °C; V <sub>I</sub> = V <sub>SS</sub> | 0                  | –    | –0.5               | μA   |
| I <sub>IH</sub>       | HIGH-level input current pins<br>TS1 and TS2<br>RDI and BAT<br>RDI and BAT<br>DON, ALC and RST                    | T <sub>amb</sub> = 25 °C                                   |                    |      |                    |      |
|                       |                                                                                                                   | V <sub>I</sub> = V <sub>DD</sub>                           | 6                  | –    | 20                 | μA   |
|                       |                                                                                                                   | V <sub>I</sub> = V <sub>DD</sub> ; RXE = 0                 | 6                  | –    | 20                 | μA   |
|                       |                                                                                                                   | V <sub>I</sub> = V <sub>DD</sub> ; RXE = 1                 | 0                  | –    | 0.5                | μA   |
|                       |                                                                                                                   | V <sub>I</sub> = V <sub>PR</sub>                           | 250                | 500  | 850                | nA   |
| Outputs               |                                                                                                                   |                                                            |                    |      |                    |      |
| I <sub>OL</sub>       | LOW-level output current pins<br>VIB and LED<br>ATH<br>INT and REF<br>ZSD, ZSC and ZLE<br>ATL<br>ROE, RXE and DQC | T <sub>amb</sub> = 25 °C                                   |                    |      |                    |      |
|                       |                                                                                                                   | V <sub>OL</sub> = 0.3 V                                    | 80                 | –    | –                  | μA   |
|                       |                                                                                                                   | V <sub>OL</sub> = 0.3 V                                    | 250                | –    | –                  | μA   |
|                       |                                                                                                                   | V <sub>OL</sub> = 0.3 V                                    | 80                 | –    | –                  | μA   |
|                       |                                                                                                                   | V <sub>OL</sub> = 0.3 V                                    | 70                 | –    | –                  | μA   |
|                       |                                                                                                                   | V <sub>OL</sub> = 1.2 V; note 2                            | 13                 | 27   | 55                 | mA   |
|                       | V <sub>OL</sub> = 0.3 V                                                                                           | 80                                                         | –                  | –    | μA                 |      |

# Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

| SYMBOL   | PARAMETER                      | CONDITIONS                             | MIN. | TYP. | MAX.  | UNIT          |
|----------|--------------------------------|----------------------------------------|------|------|-------|---------------|
| $I_{OH}$ | HIGH-level output current pins | $T_{amb} = 25\text{ }^{\circ}\text{C}$ |      |      |       |               |
|          | VIB, LED and DQC               | $V_{OH} = 0.7\text{ V}$                | -0.6 | –    | -2.4  | mA            |
|          | ATH                            | $V_{OH} = 0.7\text{ V}$                | -3.0 | –    | -11.0 | mA            |
|          | INT and REF                    | $V_{OH} = 2.4\text{ V}$                | -80  | –    | –     | $\mu\text{A}$ |
|          | ZSD, ZSC and ZLE               | $V_{OH} = 2.4\text{ V}$                | -60  | –    | –     | $\mu\text{A}$ |
|          | ATL                            | ATL high-impedance; note 3             | –    | –    | -0.5  | $\mu\text{A}$ |
|          | ROE and RXE                    | $V_{OH} = 2.4\text{ V}$                | -600 | –    | –     | $\mu\text{A}$ |

## Notes

- Inputs: SDA and SCL pulled up to  $V_{DD}$ ; all other inputs connected to  $V_{SS}$ .  
Outputs: RXE and ROE logic 0; REF:  $f_{ref} = 1/60\text{ Hz}$ ; all other outputs open-circuit.  
Oscillator: no crystal; external clock  $f_{osc} = 76800\text{ Hz}$ ; amplitude:  $V_{SS}$  to  $V_{DD}$ .  
Voltage convertor disabled (SPF byte 01, bit D7 = 0; see Table 24).
- Maximum output current is subject to absolute maximum ratings per output (see Chapter 10).
- When ATL (open-drain output) is not activated it is high impedance.

## 12 DC CHARACTERISTICS (WITH VOLTAGE CONVERTER)

$V_{DD} = 2.7\text{ V}$ ;  $V_{SS} = 0\text{ V}$ ;  $V_{PR} = V_{PO}$ ;  $T_{amb} = -25\text{ to }+70\text{ }^{\circ}\text{C}$ ;  $C_s = 100\text{ nF}$ ; voltage convertor enabled.

| SYMBOL      | PARAMETER               | CONDITIONS                                                 | MIN. | TYP. | MAX. | UNIT          |
|-------------|-------------------------|------------------------------------------------------------|------|------|------|---------------|
| $V_{DD}$    | supply voltage          |                                                            | 1.5  | –    | 3.0  | V             |
| $V_{PO(0)}$ | output voltage; no load | $V_{DD} = 2.7\text{ V}$ ; $I_{PO} = 0$                     | –    | 5.4  | –    | V             |
| $V_{PO}$    | output voltage          | $V_{DD} = 2\text{ V}$ ; $I_{PO} = -250\text{ }\mu\text{A}$ | 3.0  | 3.5  | –    | V             |
| $I_{PO}$    | output current          | $V_{DD} = 2\text{ V}$ ; $V_{PO} = 2.7\text{ V}$            | -400 | -650 | –    | $\mu\text{A}$ |
|             |                         | $V_{DD} = 3\text{ V}$ ; $V_{PO} = 4.5\text{ V}$            | -650 | -900 | –    | $\mu\text{A}$ |

## 13 OSCILLATOR CHARACTERISTICS

Quartz crystal type: MX-1V or equivalent. Quartz crystal parameters:  $f = 76\,800\text{ Hz}$ ;  $R_{S(max)} = 35\text{ k}\Omega$ ;  $C_L = 8\text{ pF}$ ;  $C_0 = 1.4\text{ pF}$ ;  $C_1 = 1.5\text{ fF}$ . Maximum overall tolerance:  $\pm 200 \times 10^{-6}$  (includes: cutting, temperature, aging) for POCSAG,  $\pm 55 \times 10^{-6}$  for APOC1 ('transmitter off' mode).

| SYMBOL   | PARAMETER                   | CONDITIONS              | MIN. | TYP. | UNIT          |
|----------|-----------------------------|-------------------------|------|------|---------------|
| $C_{XO}$ | output capacitance XTAL2    |                         | –    | 10   | pF            |
| $g_m$    | oscillator transconductance | $V_{DD} = 1.5\text{ V}$ | 6    | 12   | $\mu\text{S}$ |

# Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

## 14 AC CHARACTERISTICS

$V_{DD} = 2.7\text{ V}$ ;  $V_{SS} = 0\text{ V}$ ;  $V_{PR} = 2.7\text{ V}$ ;  $T_{amb} = 25\text{ }^{\circ}\text{C}$ ;  $f_{osc} = 76800\text{ Hz}$ .

| SYMBOLS                          | PARAMETER                                    | CONDITIONS                                           | MIN. | TYP.                | MAX. | UNIT          |
|----------------------------------|----------------------------------------------|------------------------------------------------------|------|---------------------|------|---------------|
| <b>System clock</b>              |                                              |                                                      |      |                     |      |               |
| $T_{clk}$                        | system clock period                          | $f_{osc} = 76800\text{ Hz}$                          | –    | 13.02               | –    | $\mu\text{s}$ |
| <b>Call alert frequencies</b>    |                                              |                                                      |      |                     |      |               |
| $f_{AL}$                         | alert frequency                              | SPF byte 03H; bits<br>D1 and D0 = 0 0                | –    | 2048                | –    | Hz            |
|                                  |                                              | D1 and D0 = 0 1                                      | –    | 2731                | –    | Hz            |
|                                  |                                              | D1 and D0 = 1 0                                      | –    | 3200                | –    | Hz            |
|                                  |                                              | D1 and D0 = 1 1                                      | –    | 4096                | –    | Hz            |
| $f_{AW}$                         | warbled alert; modulation frequency          | alert set-up bit D2 = 1; outputs ATL, ATH and LED    | –    | 16                  | –    | Hz            |
| $f_{AWH}$                        | warbled alert; high acoustic alert frequency | alert set-up bit D2 = 1; outputs ATL and ATH         | –    | $f_{AL}$            | –    | Hz            |
| $f_{AWL}$                        | warbled alert; low acoustic alert frequency  | alert set-up bit D2 = 1; outputs ATL and ATH         | –    | $\frac{1}{2}f_{AL}$ | –    | Hz            |
| $f_{VBP}$                        | pulsed vibrator frequency (square wave)      | low-level alert                                      | –    | 25                  | –    | Hz            |
| <b>Call alert duration</b>       |                                              |                                                      |      |                     |      |               |
| $t_{ALT}$                        | alert time-out period                        |                                                      | –    | 16                  | –    | s             |
| $t_{ALL}$                        | ATL output time-out period                   | low-level alert                                      | –    | 4                   | –    | s             |
| $t_{ALH}$                        | ATH output time-out period                   | high-level alert                                     | –    | 12                  | –    | s             |
| $t_{VBL}$                        | VIB output time-out period                   | low-level alert                                      | –    | 4                   | –    | s             |
| $t_{VBH}$                        | VIB output time-out period                   | high-level alert                                     | –    | 12                  | –    | s             |
| $t_{ALC}$                        | alert cycle period                           |                                                      | –    | 1                   | –    | s             |
| $t_{ALP}$                        | alert pulse duration                         |                                                      | –    | 125                 | –    | ms            |
| <b>Real-time clock reference</b> |                                              |                                                      |      |                     |      |               |
| $f_{ref}$                        | real-time clock reference frequency          | SPF byte 02H; bits<br>D3 and D2 = 0 0; note 1        | –    | 32 768              | –    | Hz            |
|                                  |                                              | D3 and D2 = 0 1; note 2                              | –    | 50                  | –    | Hz            |
|                                  |                                              | D3 and D2 = 1 0                                      | –    | 2                   | –    | Hz            |
|                                  |                                              | D3 and D2 = 1 1                                      | –    | $\frac{1}{60}$      | –    | Hz            |
| $t_{RFP}$                        | real-time clock reference pulse duration     | all reference frequencies except 50 Hz (square wave) | –    | 13.02               | –    | $\mu\text{s}$ |

# Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

| SYMBOLS                         | PARAMETER                                                                                             | CONDITIONS                            | MIN.             | TYP.   | MAX. | UNIT   |
|---------------------------------|-------------------------------------------------------------------------------------------------------|---------------------------------------|------------------|--------|------|--------|
| Receiver control                |                                                                                                       |                                       |                  |        |      |        |
| t <sub>RXT</sub>                | RXE and ROE transition time                                                                           | C <sub>L</sub> = 5 pF                 | –                | 100    | –    | ns     |
| t <sub>RXON</sub>               | RXE establishment time<br>(nominal values: actual duration<br>is bit rate dependent, see<br>Table 25) | SPF byte 01H; bits<br>D1 and D0 = 0 0 | –                | 5      | –    | ms     |
|                                 |                                                                                                       | D1 and D0 = 0 1                       | –                | 10     | –    | ms     |
|                                 |                                                                                                       | D1 and D0 = 1 0                       | –                | 15     | –    | ms     |
|                                 |                                                                                                       | D1 and D0 = 1 1                       | –                | 30     | –    | ms     |
| t <sub>ROON</sub>               | ROE establishment time<br>(nominal values: actual duration<br>is bit rate dependent, see<br>Table 25) | SPF byte 01H; bits<br>D3 and D2 = 0 0 | –                | 20     | –    | ms     |
|                                 |                                                                                                       | D3 and D2 = 0 1                       | –                | 30     | –    | ms     |
|                                 |                                                                                                       | D3 and D2 = 1 0                       | –                | 40     | –    | ms     |
|                                 |                                                                                                       | D3 and D2 = 1 1                       | –                | 50     | –    | ms     |
| I <sup>2</sup> C-bus interface  |                                                                                                       |                                       |                  |        |      |        |
| f <sub>SCL</sub>                | SCL clock frequency                                                                                   |                                       | 0                | –      | 100  | kHz    |
| t <sub>LOW</sub>                | SCL clock low period                                                                                  |                                       | 4.7              | –      | –    | μs     |
| t <sub>HIGH</sub>               | SCL clock HIGH period                                                                                 |                                       | 4.0              | –      | –    | μs     |
| t <sub>SU;DAT</sub>             | data set-up time                                                                                      |                                       | 250              | –      | –    | ns     |
| t <sub>HD;DAT</sub>             | data hold time                                                                                        |                                       | 500              | –      | –    | ns     |
| t <sub>r</sub>                  | SDA and SCL rise time                                                                                 |                                       | –                | –      | 1000 | ns     |
| t <sub>f</sub>                  | SDA and SCL fall time                                                                                 |                                       | –                | –      | 300  | ns     |
| C <sub>B</sub>                  | capacitive bus line load                                                                              |                                       | –                | –      | 400  | pF     |
| t <sub>SU;STA</sub>             | START condition set-up time                                                                           |                                       | 4.7              | –      | –    | μs     |
| t <sub>HD;STA</sub>             | START condition hold time                                                                             |                                       | 4.0              | –      | –    | μs     |
| t <sub>SU;STO</sub>             | STOP condition set-up time                                                                            |                                       | 4.0              | –      | –    | μs     |
| Reset                           |                                                                                                       |                                       |                  |        |      |        |
| t <sub>RST</sub>                | external reset duration                                                                               |                                       | 50               | –      | –    | μs     |
| t <sub>RSU</sub>                | set-up time after reset                                                                               | oscillator running                    | –                | –      | 105  | μs     |
| t <sub>OSU</sub>                | set-up time after switch-on                                                                           | oscillator running                    | –                | –      | 4    | ms     |
| Data input                      |                                                                                                       |                                       |                  |        |      |        |
| t <sub>TDI</sub>                | data input transition time                                                                            | see Fig.15                            | –                | –      | 100  | μs     |
| t <sub>DI1</sub>                | data input logic 1 duration                                                                           | see Fig.15                            | t <sub>BIT</sub> | –      | ∞    |        |
| t <sub>DI0</sub>                | data input logic 0 duration                                                                           | see Fig.15                            | t <sub>BIT</sub> | –      | ∞    |        |
| POCSAG data timing (512 bits/s) |                                                                                                       |                                       |                  |        |      |        |
| f <sub>DI</sub>                 | data input rate                                                                                       | SPF byte 01H; D5 = 0; D4 = 0          | –                | 512    | –    | bits/s |
| t <sub>BIT</sub>                | bit duration                                                                                          |                                       | –                | 1.9531 | –    | ms     |
| t <sub>CW</sub>                 | code-word duration                                                                                    |                                       | –                | 62.5   | –    | ms     |
| t <sub>PA</sub>                 | preamble duration                                                                                     |                                       | 1125             | –      | –    | ms     |
| t <sub>BAT</sub>                | batch duration                                                                                        |                                       | –                | 1062.5 | –    | ms     |

# Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

| SYMBOLS                          | PARAMETER                   | CONDITIONS                               | MIN. | TYP.   | MAX. | UNIT   |
|----------------------------------|-----------------------------|------------------------------------------|------|--------|------|--------|
| POCSAG data timing (1200 bits/s) |                             |                                          |      |        |      |        |
| f <sub>DI</sub>                  | data input rate             | SPF byte 01H; D5 = 1; D4 = 0             | –    | 1200   | –    | bits/s |
| t <sub>BIT</sub>                 | bit duration                |                                          | –    | 833.3  | –    | μs     |
| t <sub>CW</sub>                  | code-word duration          |                                          | –    | 26.7   | –    | ms     |
| t <sub>PA</sub>                  | preamble duration           |                                          | 480  | –      | –    | ms     |
| t <sub>BAT</sub>                 | batch duration              |                                          | –    | 453.3  | –    | ms     |
| POCSAG data timing (2400 bits/s) |                             |                                          |      |        |      |        |
| f <sub>DI</sub>                  | data input rate             | SPF byte 01H; D5 = 1; D4 = 1             | –    | 2400   | –    | bits/s |
| t <sub>BIT</sub>                 | bit duration                |                                          | –    | 416.6  | –    | μs     |
| t <sub>CW</sub>                  | code-word duration          |                                          | –    | 13.3   | –    | ms     |
| t <sub>PA</sub>                  | preamble duration           |                                          | 240  | –      | –    | ms     |
| t <sub>BAT</sub>                 | batch duration              |                                          | –    | 226.6  | –    | ms     |
| APOC1 batch timing               |                             |                                          |      |        |      |        |
| t <sub>SB</sub>                  | cycle duration              | SPF byte 00H; bit D2 = 0<br>(5 batches)  | –    | 2720   | –    | bits   |
|                                  |                             | SPF byte 00H; bit D2 = 0<br>(15 batches) | –    | 8160   | –    | bits   |
| Synthesizer control              |                             |                                          |      |        |      |        |
| t <sub>ZSU</sub>                 | synthesizer set-up duration | oscillator running; note 3               | 1    | –      | 2    | bits   |
| f <sub>ZSC</sub>                 | output clock frequency      | note 4                                   | –    | 38400  | –    | Hz     |
| t <sub>ZCL</sub>                 | clock pulse duration        |                                          | –    | 13.02  | –    | μs     |
| t <sub>ZSD</sub>                 | data bit duration           | note 4                                   | –    | 26.04  | –    | μs     |
| t <sub>ZDS</sub>                 | data bit set-up time        |                                          | –    | 13.02  | –    | μs     |
| t <sub>ZDL1</sub>                | data load enable delay      |                                          | –    | 91.15  | –    | μs     |
| t <sub>ZLE</sub>                 | load enable pulse duration  |                                          | –    | 13.02  | –    | μs     |
| t <sub>ZDL2</sub>                | inter block delay           |                                          | –    | 117.19 | –    | μs     |

## Notes

- 32768 Hz reference signal; 32 pulses per 75 clock cycles, alternately separated by 1 or 2 pulse periods (pulse duration:  $t_{RFP}$ ). The timing is shown in Fig.16.
- 50 Hz reference signal: square wave.
- Duration depends on programmed bit rate; after reset  $t_{ZSU} = 1.5$  bits.
- Nominal values; pause in 12th data bit (see Table 11).

Enhanced Pager Decoder for  
APOC1/POCSAG

PCD5002A

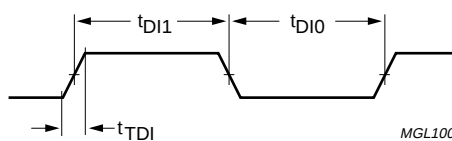


Fig.15 Data input timing.

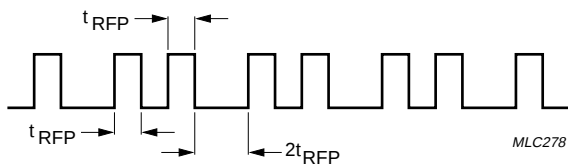
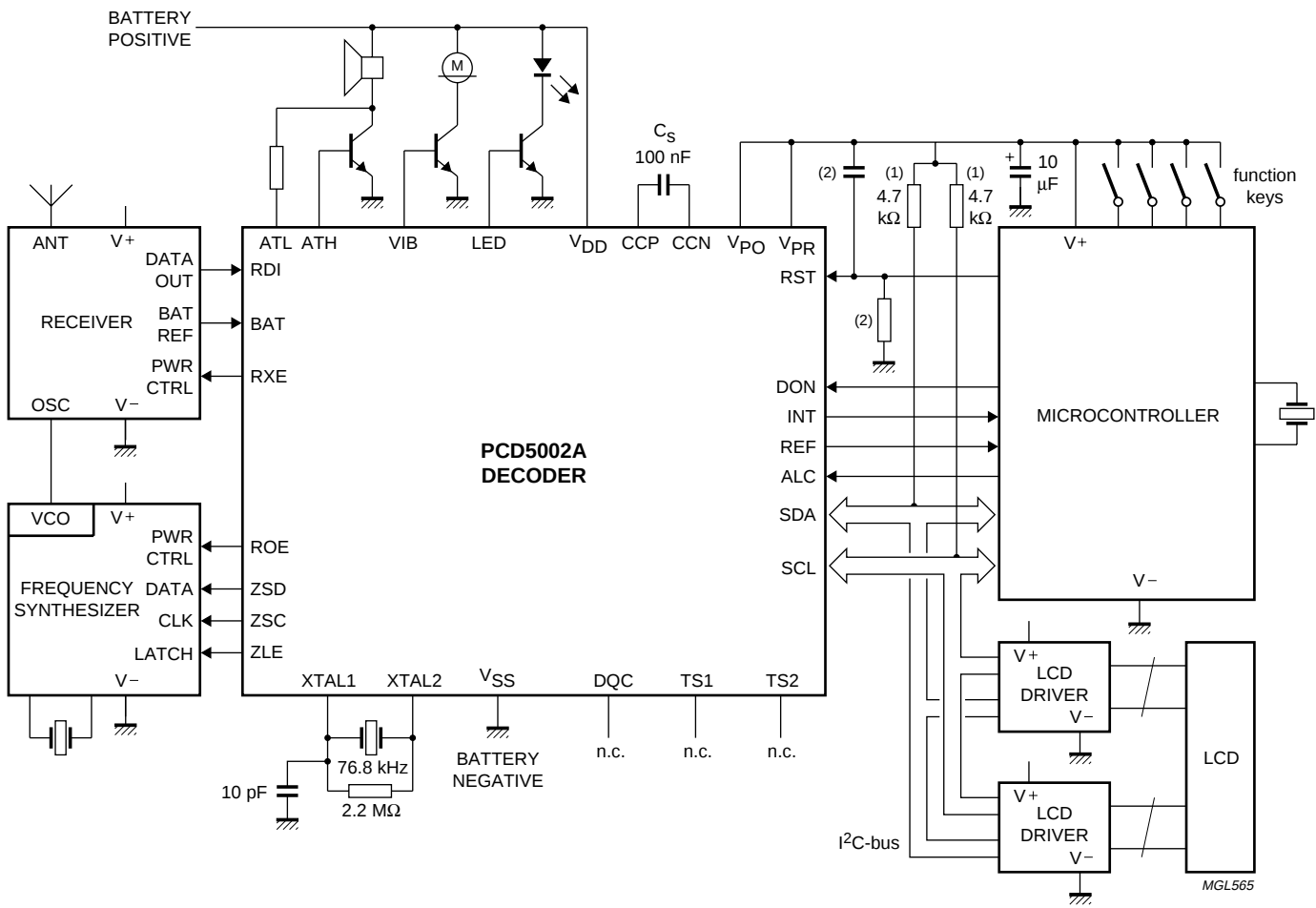


Fig.16 Timing of the 32 768 Hz reference signal.

# Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

## 15 APPLICATION INFORMATION



- (1) Value depends on number of devices attached.  
(2) Values should be chosen to give a time constant of at least 150 µs. C = 2.2 nF and R = 100 kΩ are recommended.

Fig.17 Typical application example (display pager).

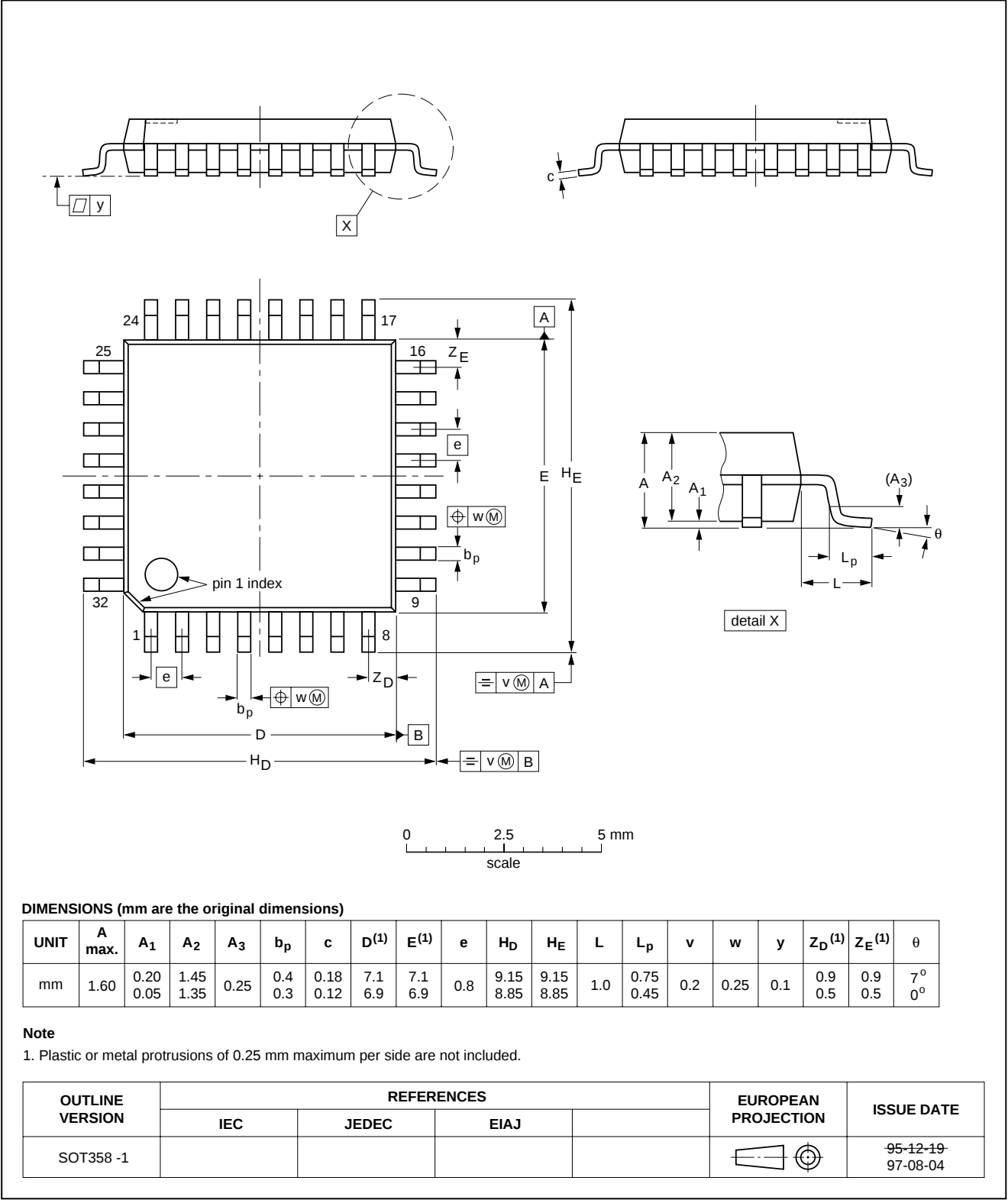
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APOC1/POCSAG

PCD5002A

16 PACKAGE OUTLINE

LQFP32: plastic low profile quad flat package; 32 leads; body 7 x 7 x 1.4 mm

SOT358-1



## Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

### 17 SOLDERING

#### 17.1 Introduction to soldering surface mount packages

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"Data Handbook IC26; Integrated Circuit Packages"* (document order number 9398 652 90011).

There is no soldering method that is ideal for all surface mount IC packages. Wave soldering is not always suitable for surface mount ICs, or for printed-circuit boards with high population densities. In these situations reflow soldering is often used.

#### 17.2 Reflow soldering

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement.

Several methods exist for reflowing; for example, infrared/convection heating in a conveyor type oven. Throughput times (preheating, soldering and cooling) vary between 100 and 200 seconds depending on heating method.

Typical reflow peak temperatures range from 215 to 250 °C. The top-surface temperature of the packages should preferably be kept below 230 °C.

#### 17.3 Wave soldering

Conventional single wave soldering is not recommended for surface mount devices (SMDs) or printed-circuit boards with a high component density, as solder bridging and non-wetting can present major problems.

To overcome these problems the double-wave soldering method was specifically developed.

If wave soldering is used the following conditions must be observed for optimal results:

- Use a double-wave soldering method comprising a turbulent wave with high upward pressure followed by a smooth laminar wave.
- For packages with leads on two sides and a pitch (e):
  - larger than or equal to 1.27 mm, the footprint longitudinal axis is **preferred** to be parallel to the transport direction of the printed-circuit board;
  - smaller than 1.27 mm, the footprint longitudinal axis **must** be parallel to the transport direction of the printed-circuit board.

The footprint must incorporate solder thieves at the downstream end.

- For packages with leads on four sides, the footprint must be placed at a 45° angle to the transport direction of the printed-circuit board. The footprint must incorporate solder thieves downstream and at the side corners.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

#### 17.4 Manual soldering

Fix the component by first soldering two diagonally-opposite end leads. Use a low voltage (24 V or less) soldering iron applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C.

When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

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PCD5002A

### 17.5 Suitability of surface mount IC packages for wave and reflow soldering methods

| PACKAGE                  | SOLDERING METHOD                  |                       |
|--------------------------|-----------------------------------|-----------------------|
|                          | WAVE                              | REFLOW <sup>(1)</sup> |
| HLQFP, HSQFP, HSOP, SMS  | not suitable <sup>(2)</sup>       | suitable              |
| PLCC <sup>(3)</sup> , SO | suitable                          | suitable              |
| LQFP, QFP, TQFP          | not recommended <sup>(3)(4)</sup> | suitable              |
| SQFP                     | not suitable                      | suitable              |
| SSOP, TSSOP, VSO         | not recommended <sup>(5)</sup>    | suitable              |

#### Notes

1. All surface mount (SMD) packages are moisture sensitive. Depending upon the moisture content, the maximum temperature (with respect to time) and body size of the package, there is a risk that internal or external package cracks may occur due to vaporization of the moisture in them (the so called popcorn effect). For details, refer to the Drypack information in the *"Data Handbook IC26; Integrated Circuit Packages; Section: Packing Methods"*.
2. These packages are not suitable for wave soldering as a solder joint between the printed-circuit board and heatsink (at bottom version) can not be achieved, and as solder may stick to the heatsink (on top version).
3. If wave soldering is considered, then the package must be placed at a 45° angle to the solder wave direction. The package footprint must incorporate solder thieves downstream and at the side corners.
4. Wave soldering is only suitable for LQFP, TQFP and QFP packages with a pitch (e) equal to or larger than 0.8 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.65 mm.
5. Wave soldering is only suitable for SSOP and TSSOP packages with a pitch (e) equal to or larger than 0.65 mm; it is definitely not suitable for packages with a pitch (e) equal to or smaller than 0.5 mm.

# Enhanced Pager Decoder for APOC1/POCSAG

PCD5002A

## 18 DEFINITIONS

| Data sheet status                                                                                                                                                                                                                                                                                                                                                                                                                                         |                                                                                       |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|
| Objective specification                                                                                                                                                                                                                                                                                                                                                                                                                                   | This data sheet contains target or goal specifications for product development.       |
| Preliminary specification                                                                                                                                                                                                                                                                                                                                                                                                                                 | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification                                                                                                                                                                                                                                                                                                                                                                                                                                     | This data sheet contains final product specifications.                                |
| Limiting values                                                                                                                                                                                                                                                                                                                                                                                                                                           |                                                                                       |
| Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability. |                                                                                       |
| Application information                                                                                                                                                                                                                                                                                                                                                                                                                                   |                                                                                       |
| Where application information is given, it is advisory and does not form part of the specification.                                                                                                                                                                                                                                                                                                                                                       |                                                                                       |

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